

# ATLAS ITk Strip Module QC-Electrical Test at IHEP

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On behalf of THU/IHEP ATLAS ITk Group

Aug. 11, 2020



清华大学  
Tsinghua University

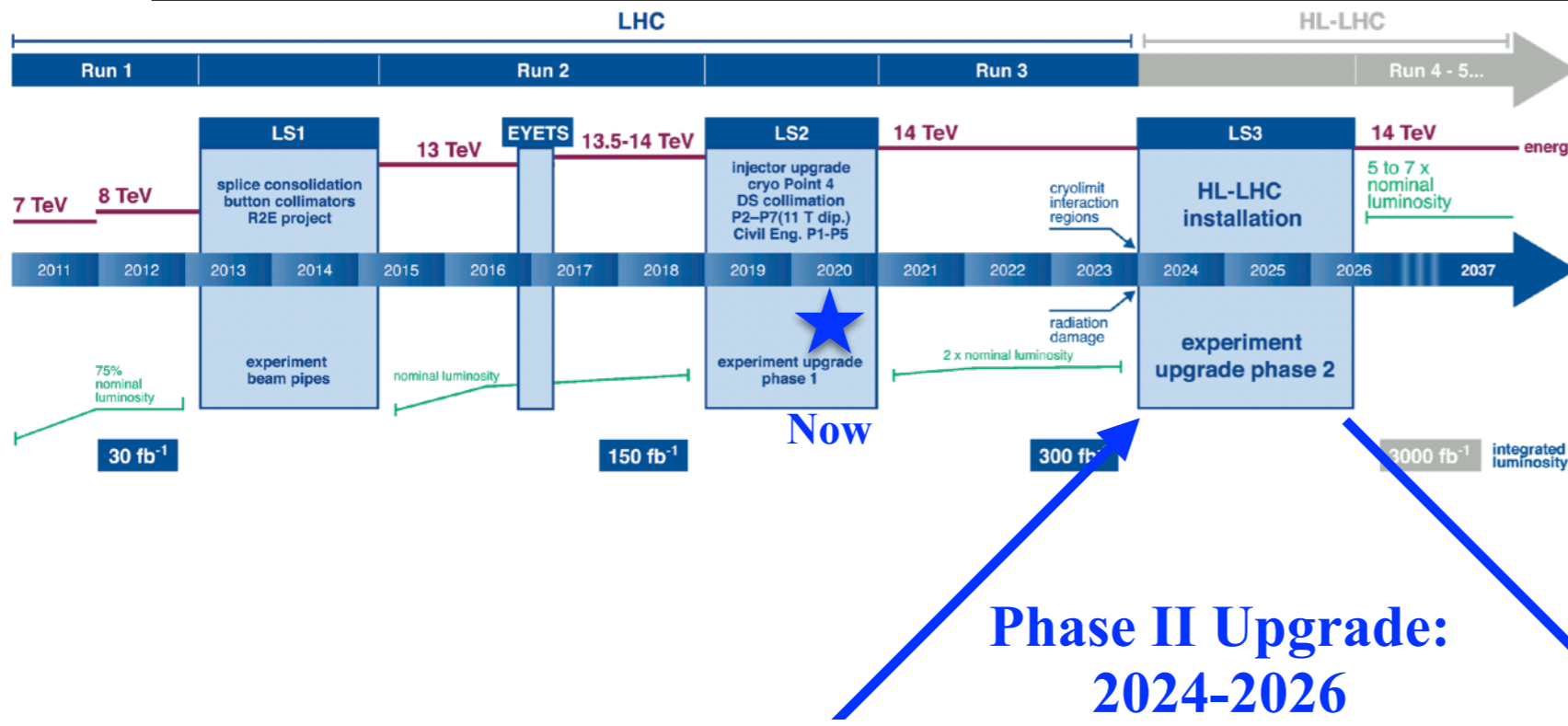


LHC Detector Upgrade Workshop



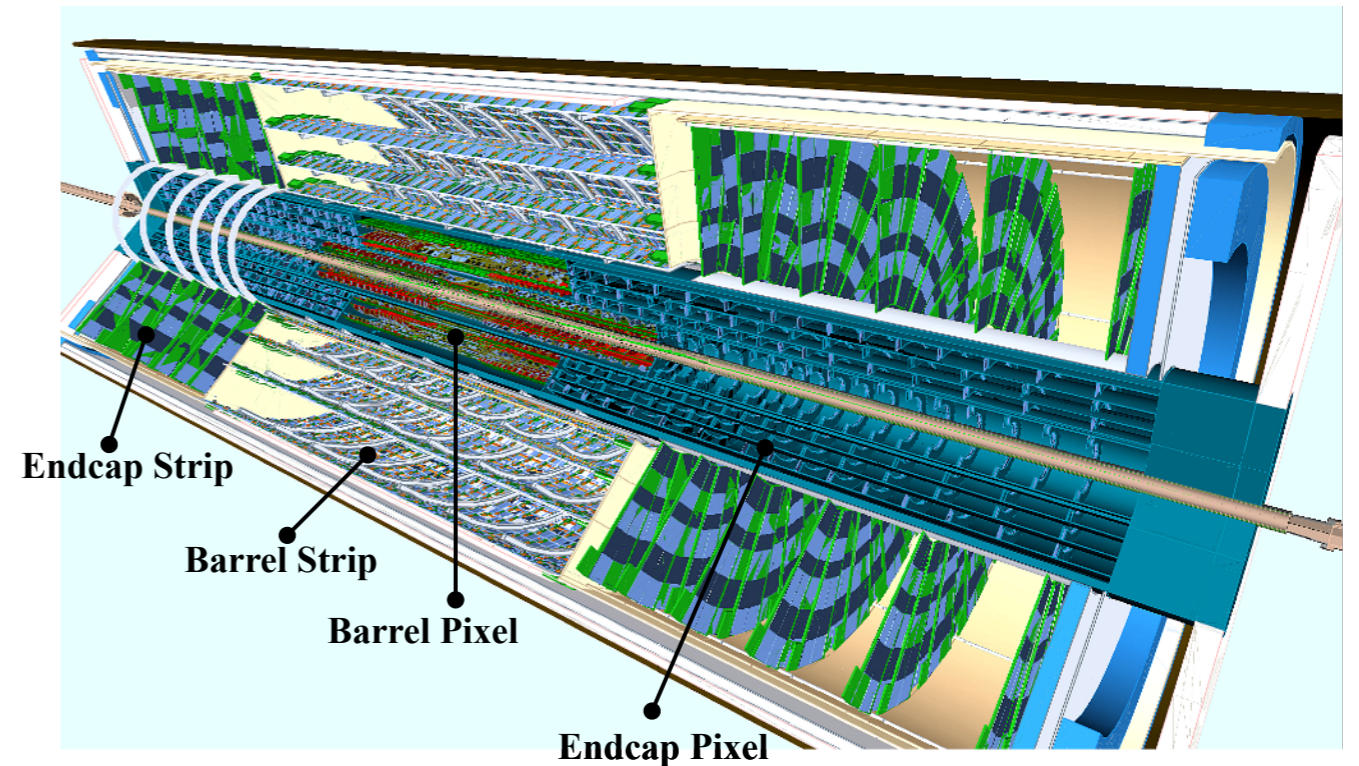
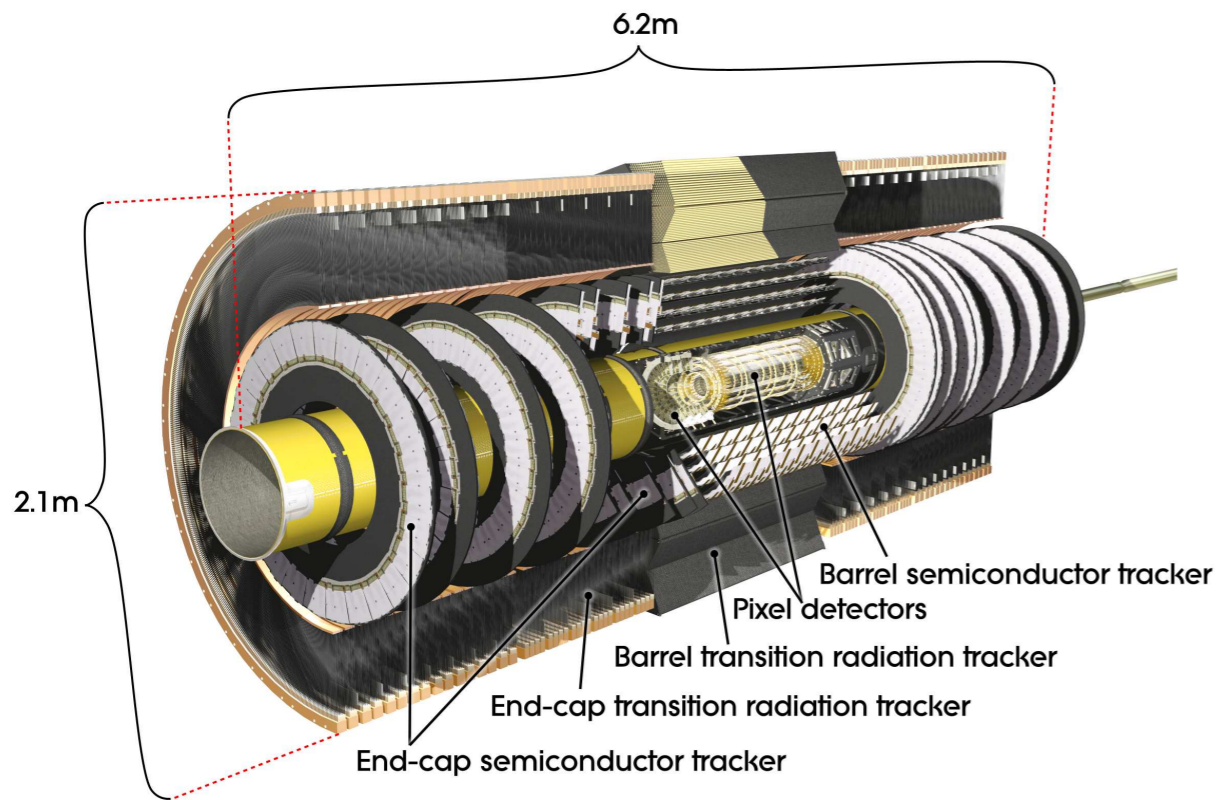
- Introduction to ATLAS ITk Strip Detector
- Electrical Test on Hybrid
- Electrical Test on Strip Module
- Summary and Plan

# ATLAS ITk Upgrade



## HL-LHC:

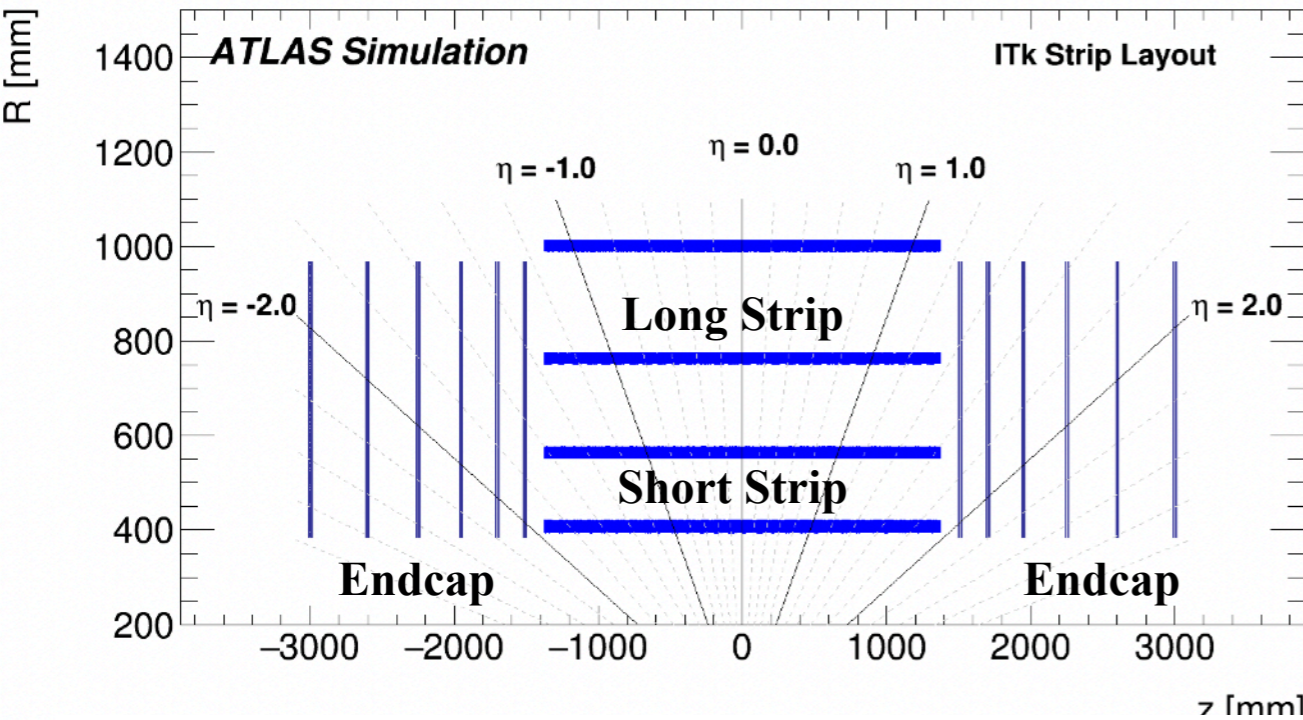
- $\mathcal{L} = 5 - 7.5 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$
- Max Pileup events:  $\sim 200$
- $4000 \text{ fb}^{-1}$  in  $>10$  years
- $>10$  times radiation



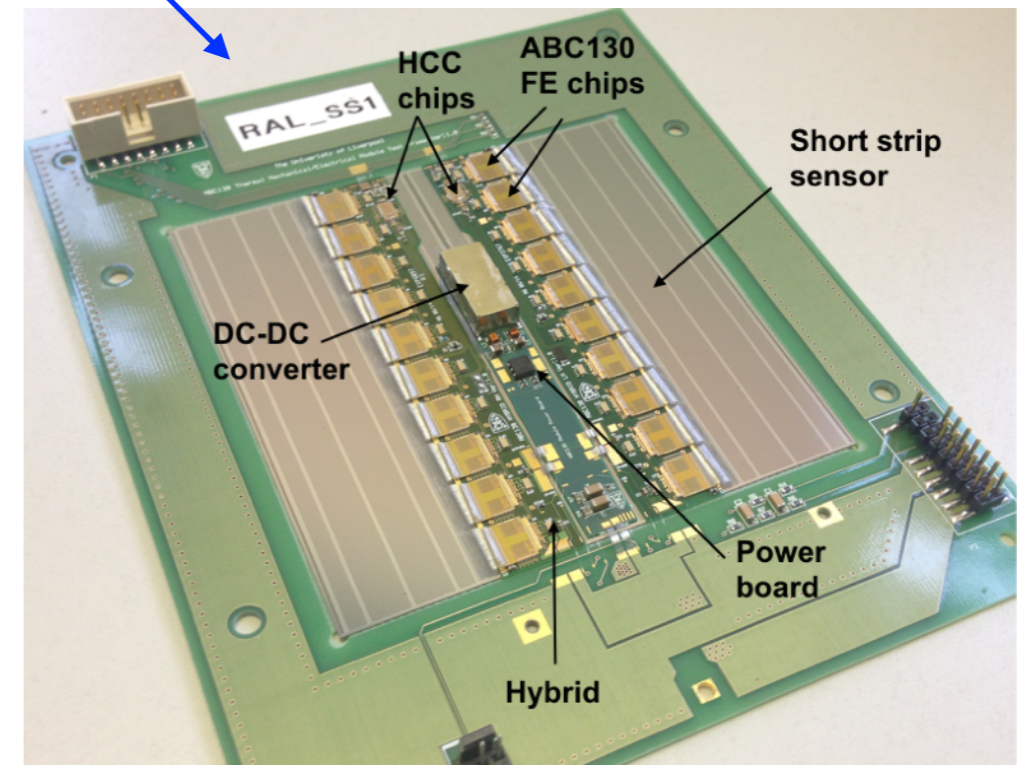
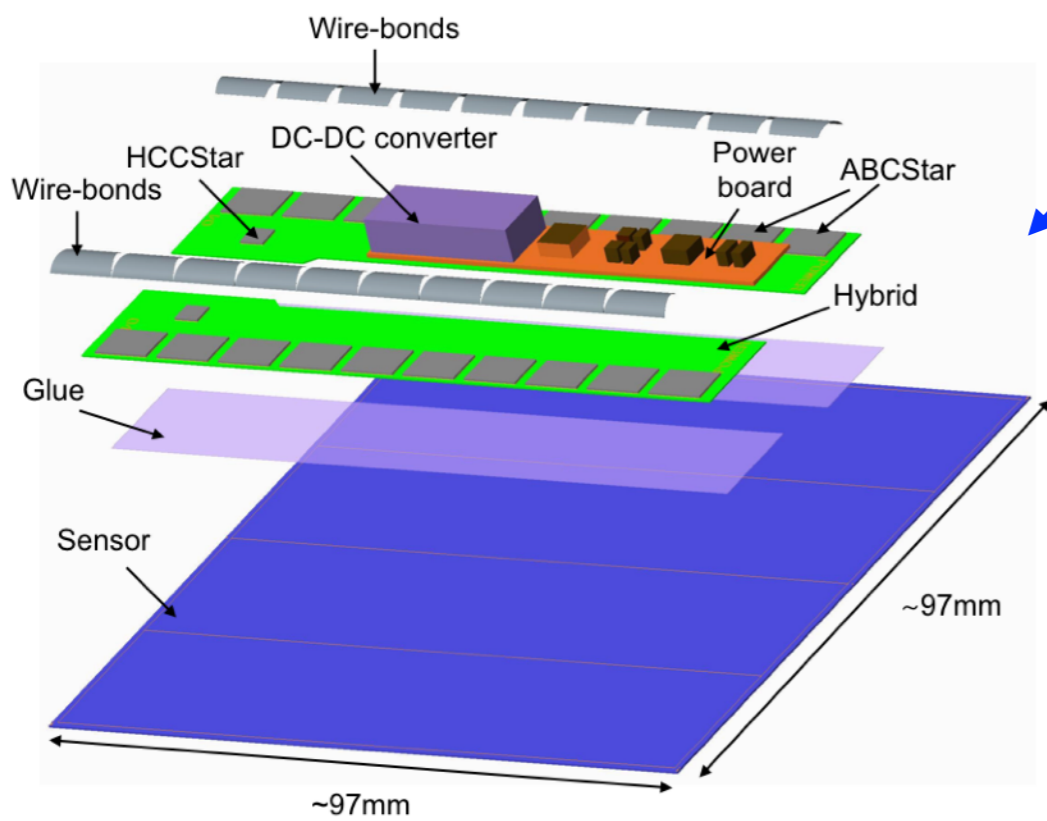
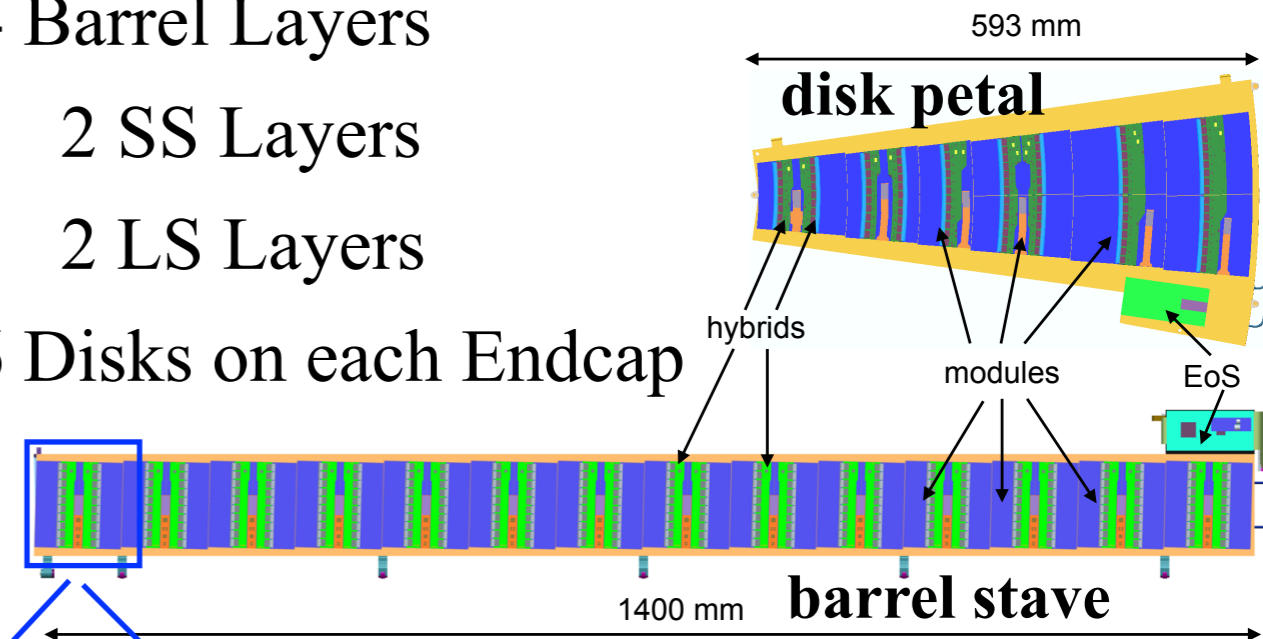
• Pixel • SCT • TRT

• ITk Pixel • ITk Strip

# ATLAS ITk Strip Detector

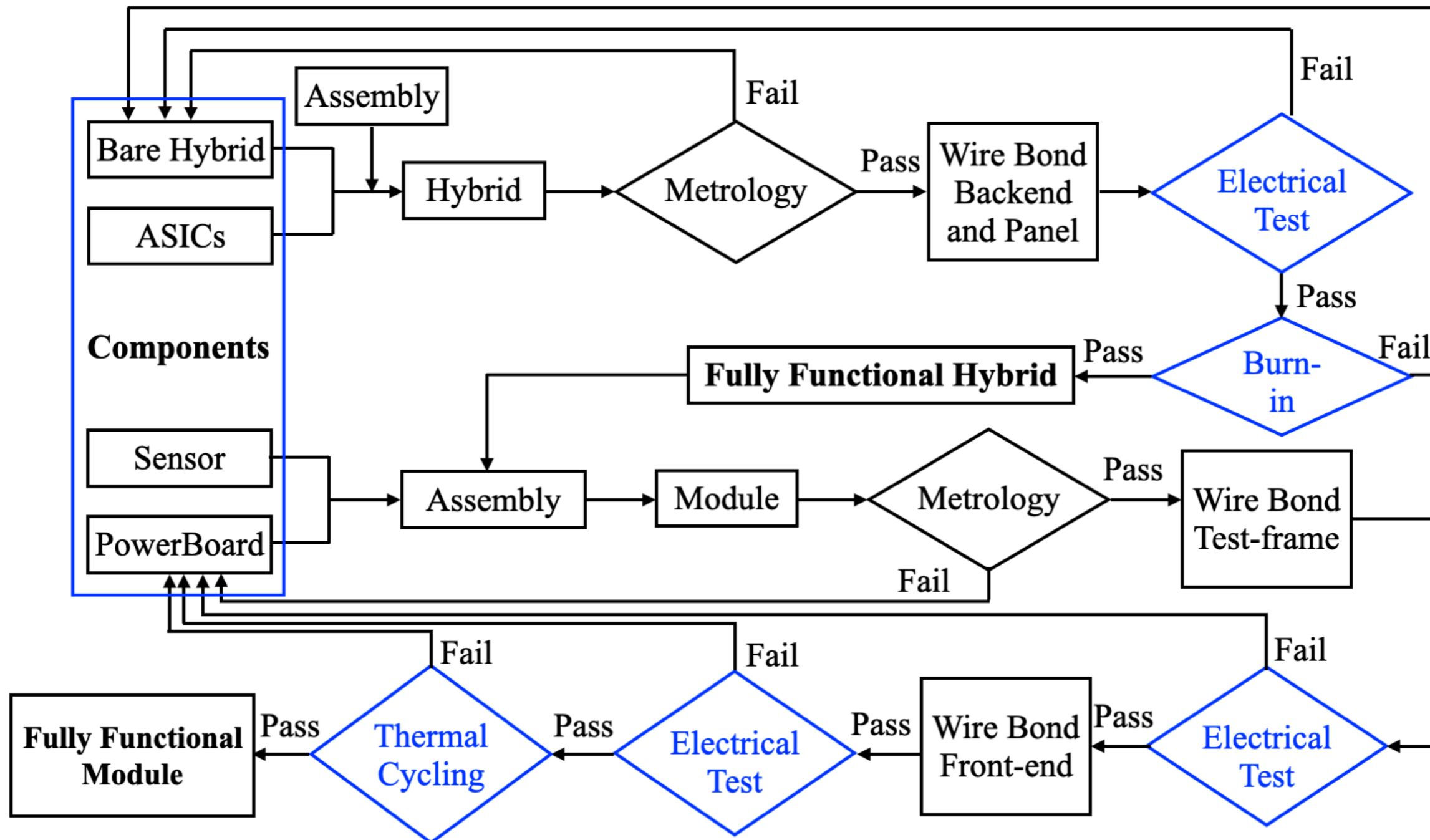


- 4 Barrel Layers
  - 2 SS Layers
  - 2 LS Layers
- 6 Disks on each Endcap

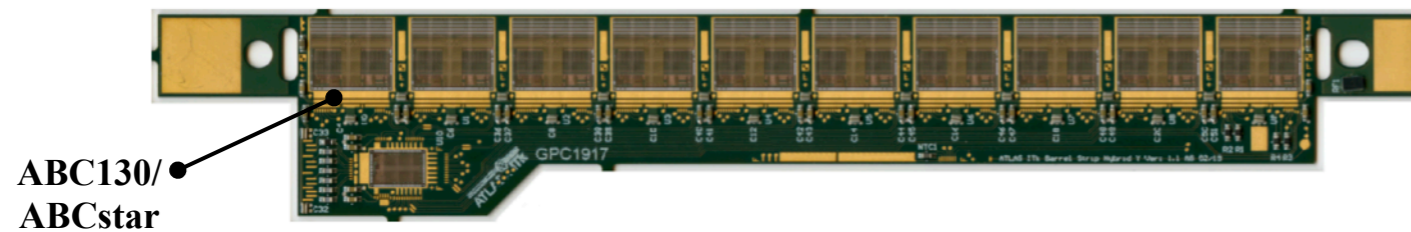


**THU/IHEP will contribute 500 Strip Barrel Modules.**

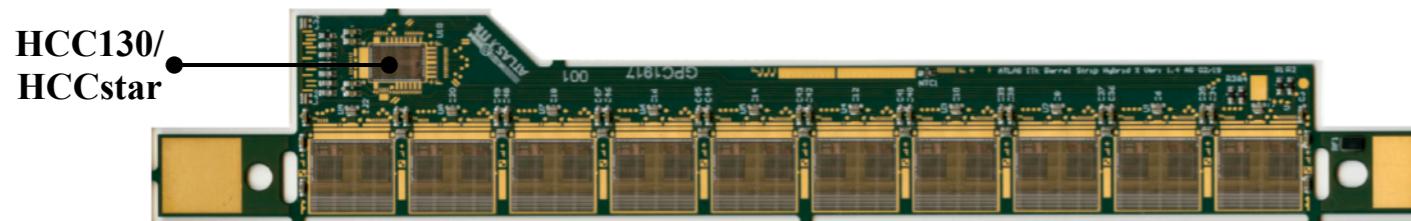
# Module Production Flow



- The hybrid is a flexible PCB retaining the required circuitry,
- Two types: X-Type, Y-Type,
- Two types of custom ASICs: 10 ABCs and 1 HCC:
  - HCC/ABC130(prototype), daisy-chain architecture,
  - HCC/ABCStar(production), star architecture

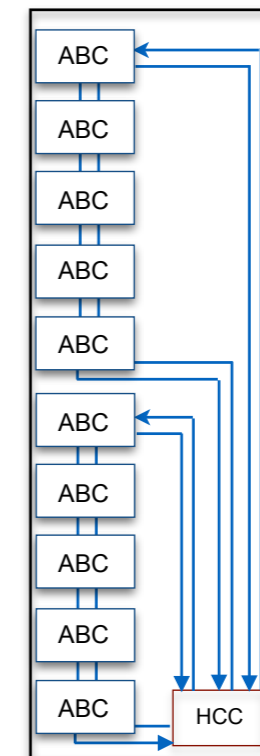


(a) Y barrel hybrid.

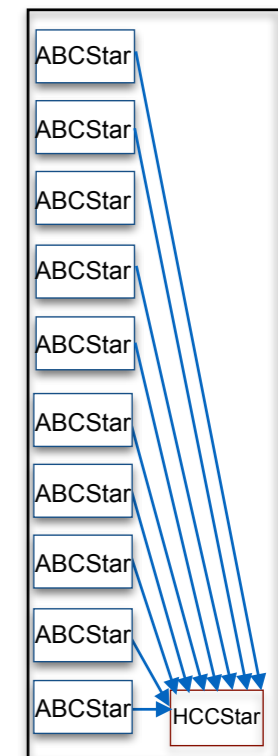


(b) X barrel hybrid.

Daisy-Chain

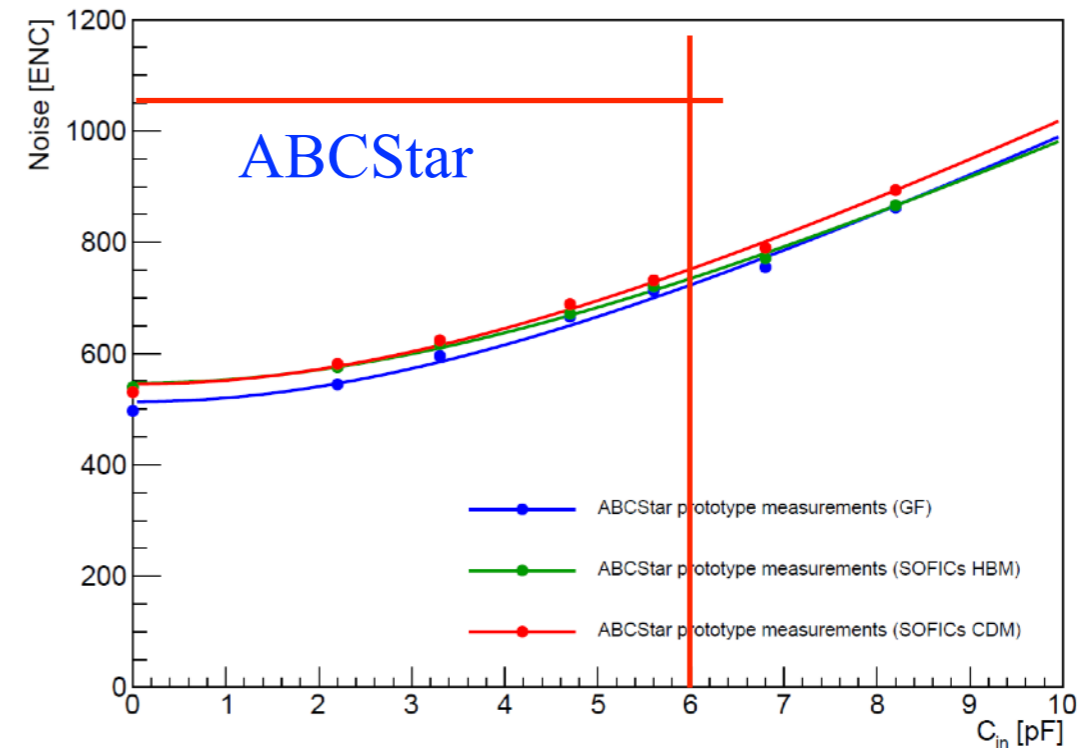
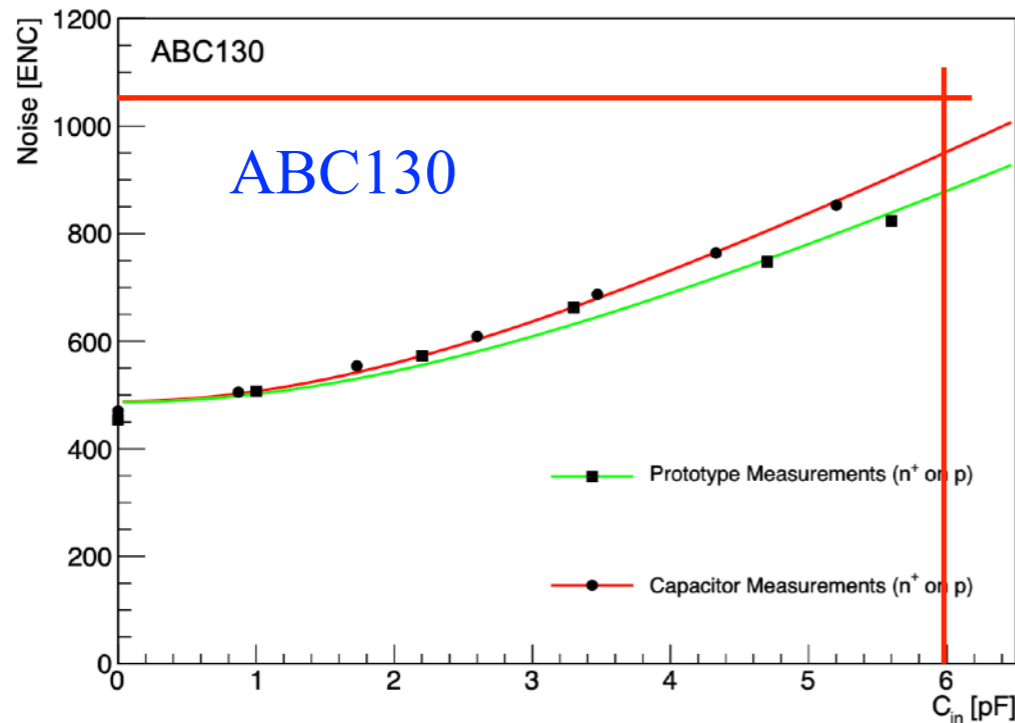
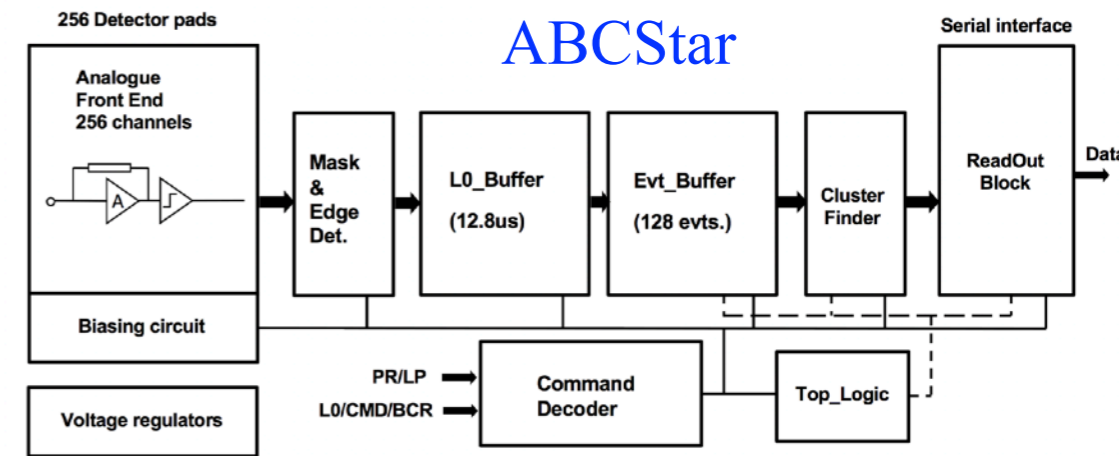


Star



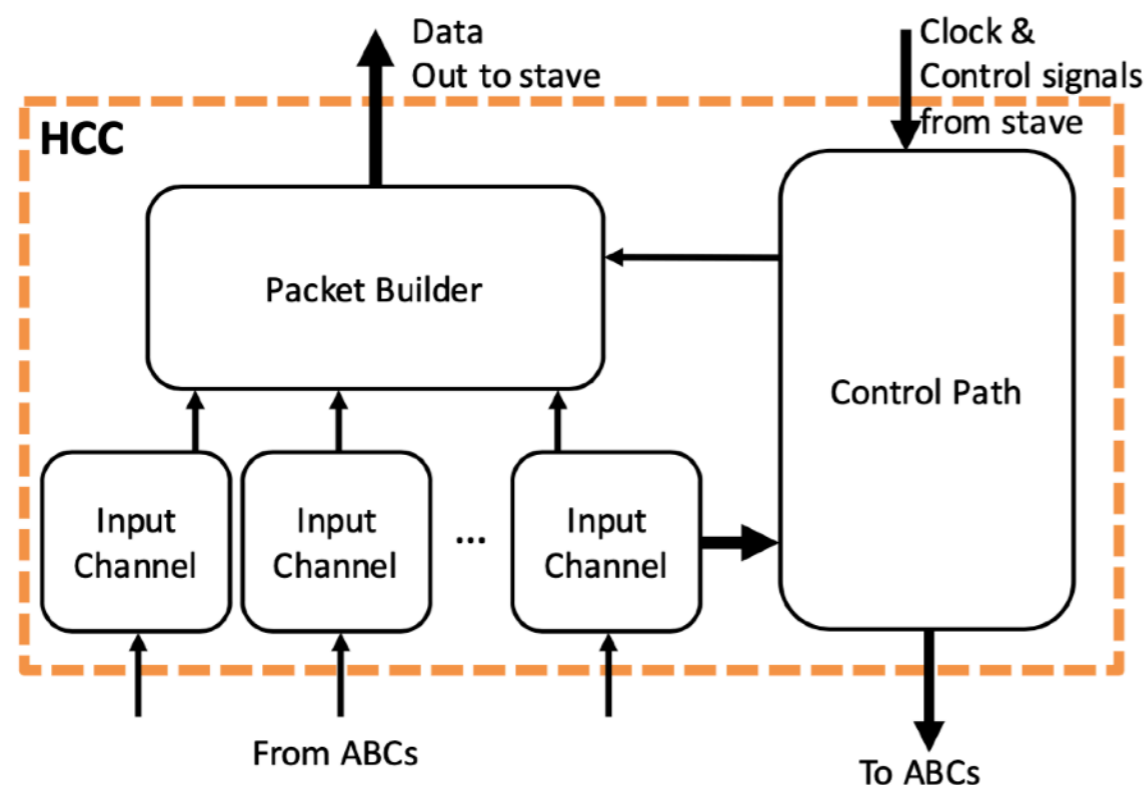
# ASIC-ABC(ATLAS Binary Chip)

- Converting incoming charge signal information into hit information,
- Processes signals from 256 strips of a silicon strip detector.
- $ENC < 900 e^- @ C_{in} = 3.5 pF$  (SS Module)
- $ENC < 1050 e^- @ C_{in} = 6 pF$  (LS Module)

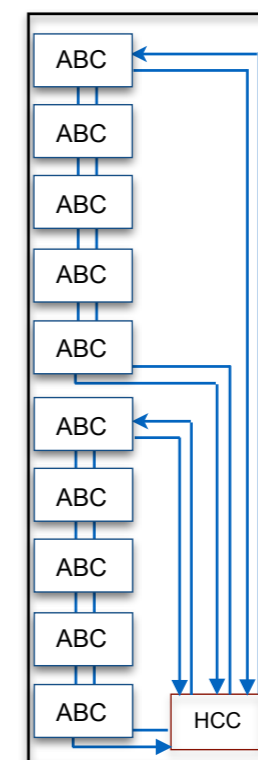


# ASIC-HCC(Hybrid Controller Chip)

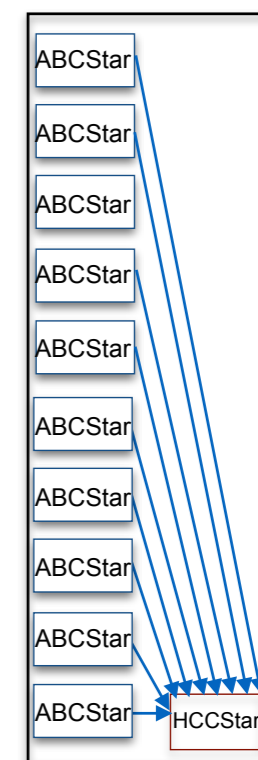
- Interface between stave/petal service bus and the front-end ASICs,
- Receives the signals from the ABCs, builds packets and transmit to EoS,
- Receives the clock and control signals (TTC) and distributes to the ABCs,
- More inputs from ABCStars to HCCStar.



Daisy-Chain



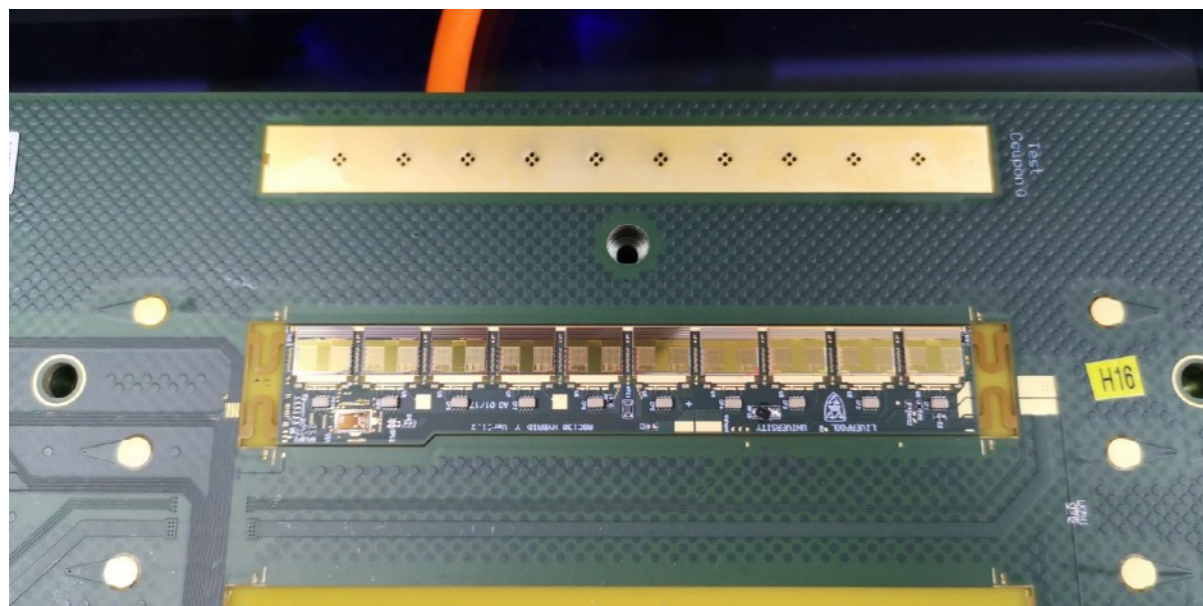
Star



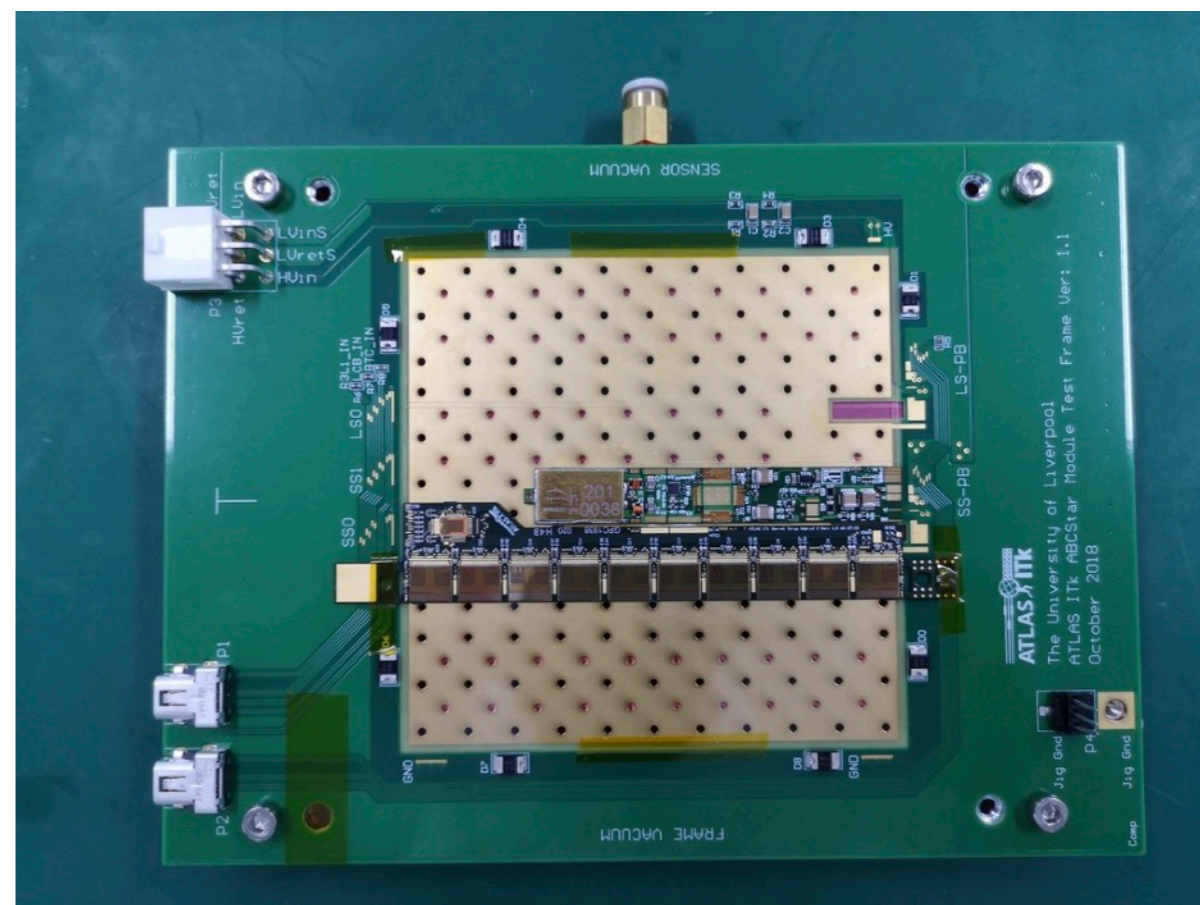


- Two X-Hybrids and two Y-Hybrids with ABC/HCC130,
- Three X-Hybrids with ABC/HCCStar.

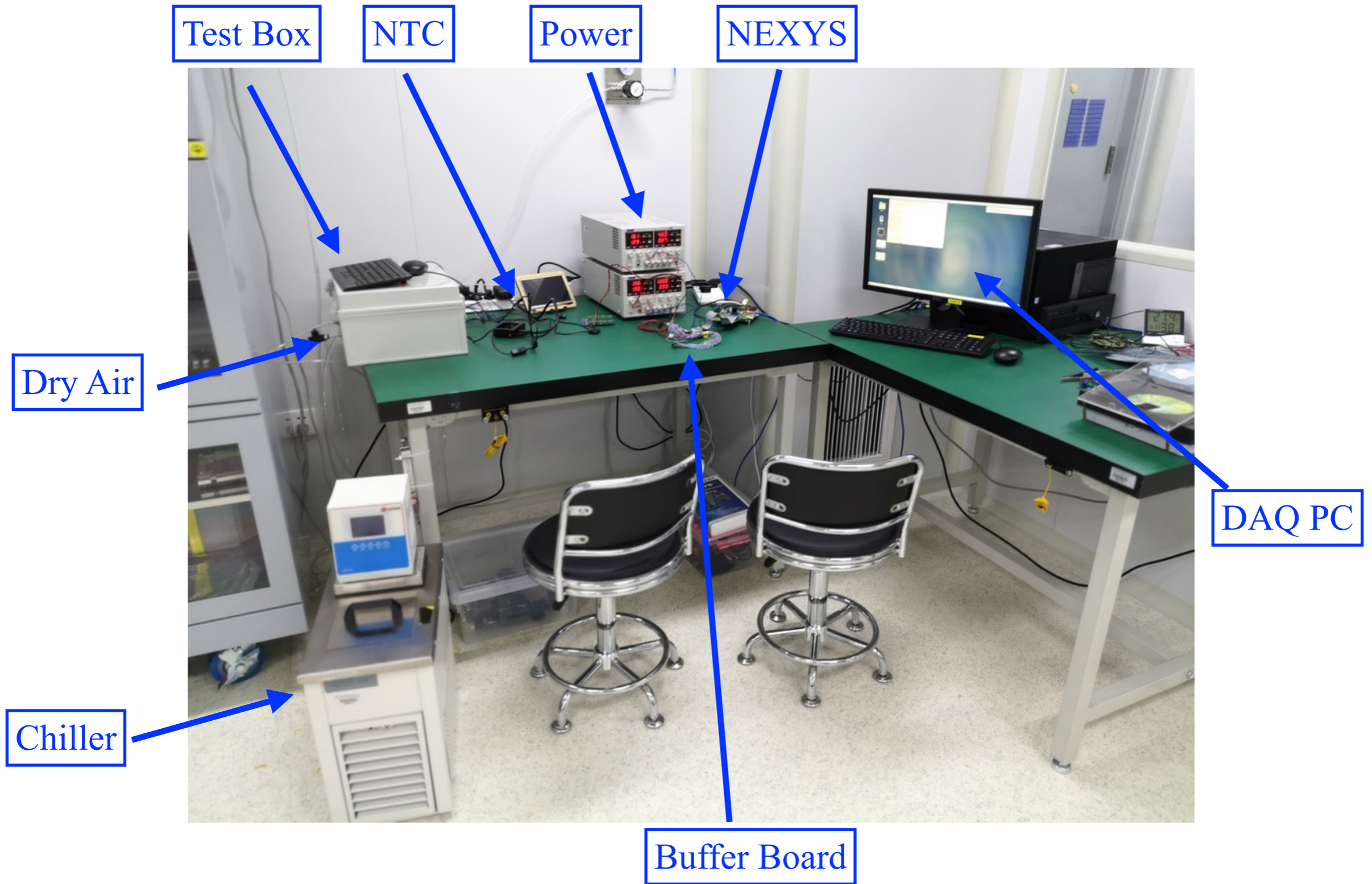
Hybrid with ABC/HCC130



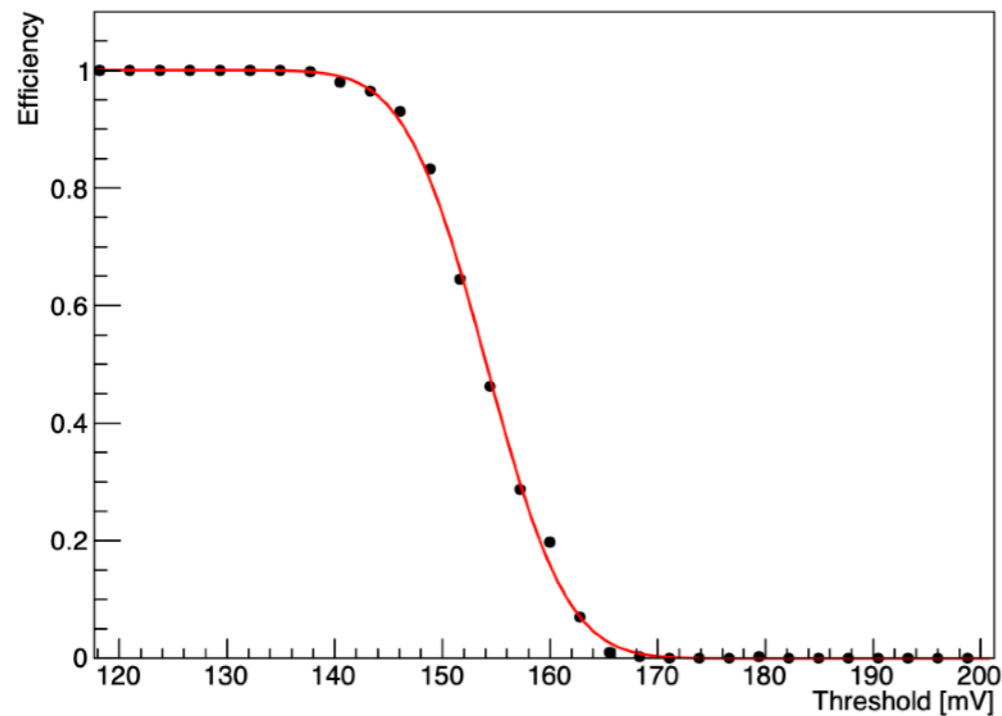
Hybrid with ABC/HCCStar



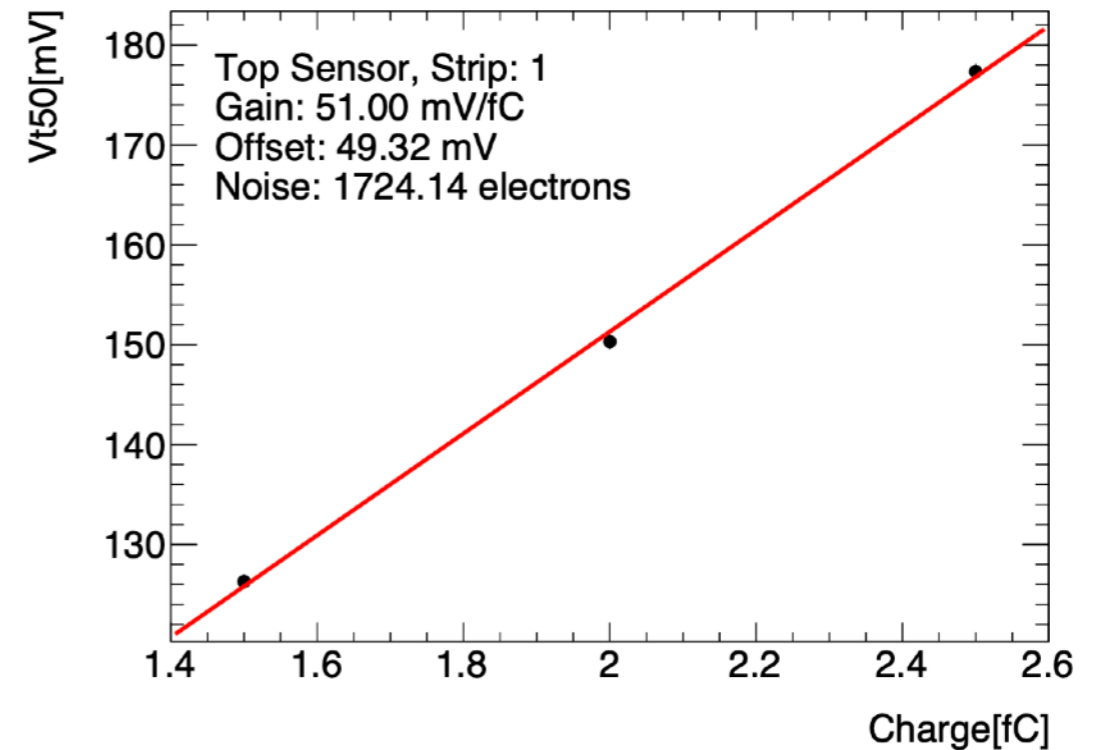
# Electrical Test Setup



- Check for front-end chip functionality:
  - Chip Communication,
  - Strobe delay to determine the delay of the injecting and arrival time of signal,
  - Three Point Gain to determine discriminator offset, channel gain and input noise,
  - Noise Occupancy to measure the noise occupancy as a function of threshold.



S-Curve to determine  $V_{t50}$  and sigma

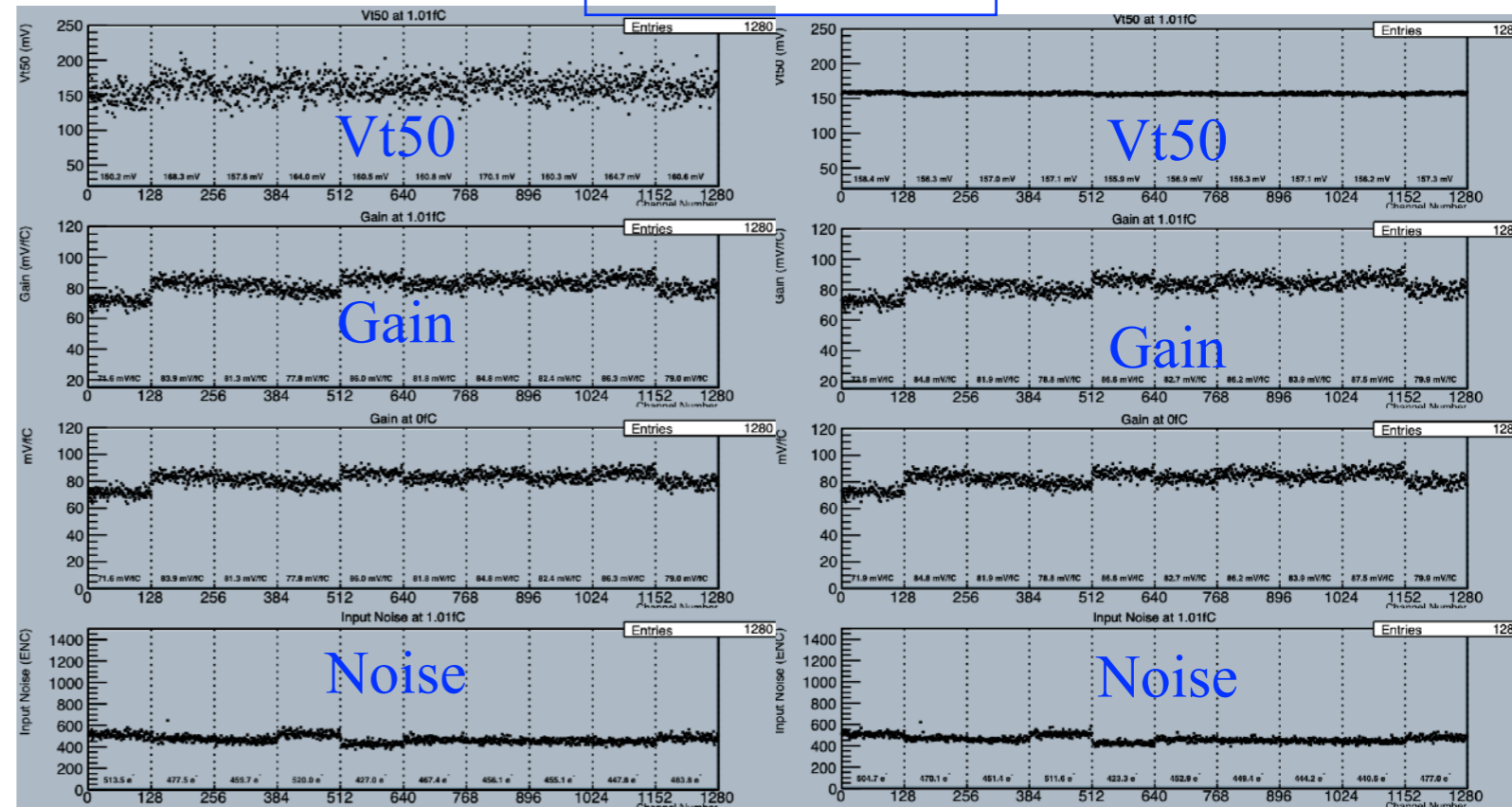
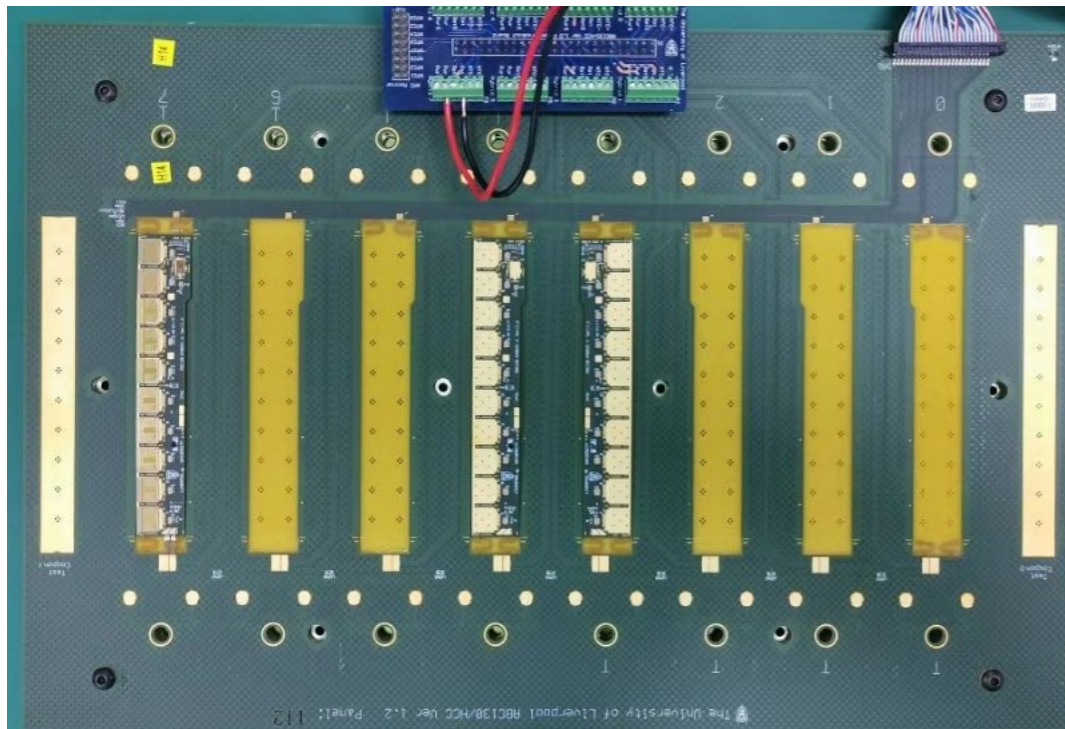


Response Curve to determine offset, gain, noise

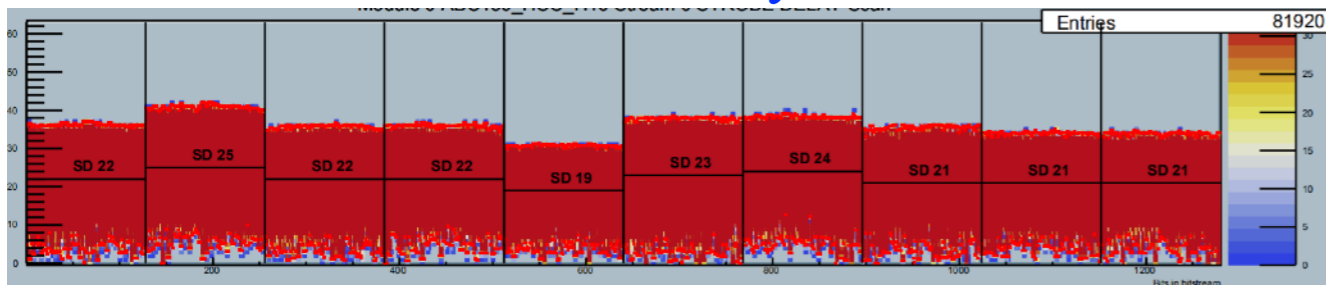
# Electrical Test on Hybrid with 130 ASICs



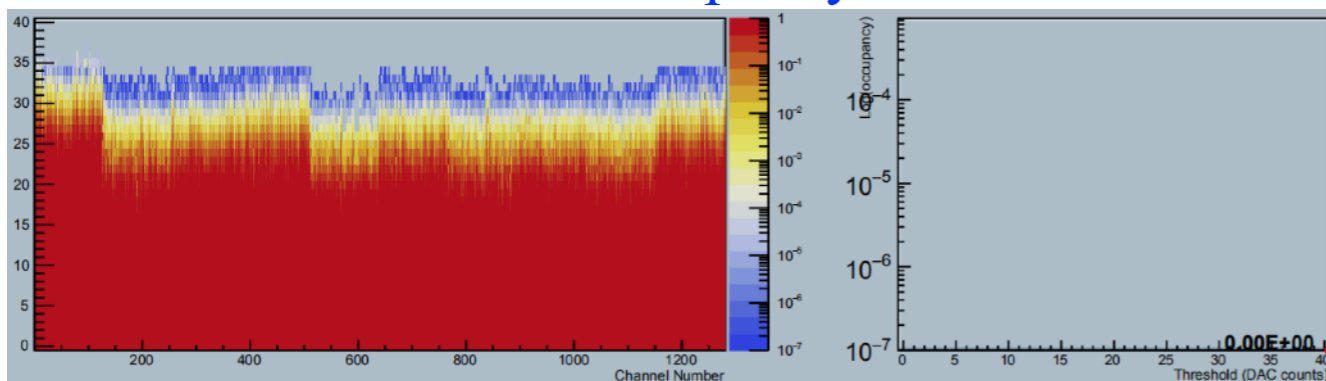
Before Trim **3 Points Gain** After Trim



Strobe Delay



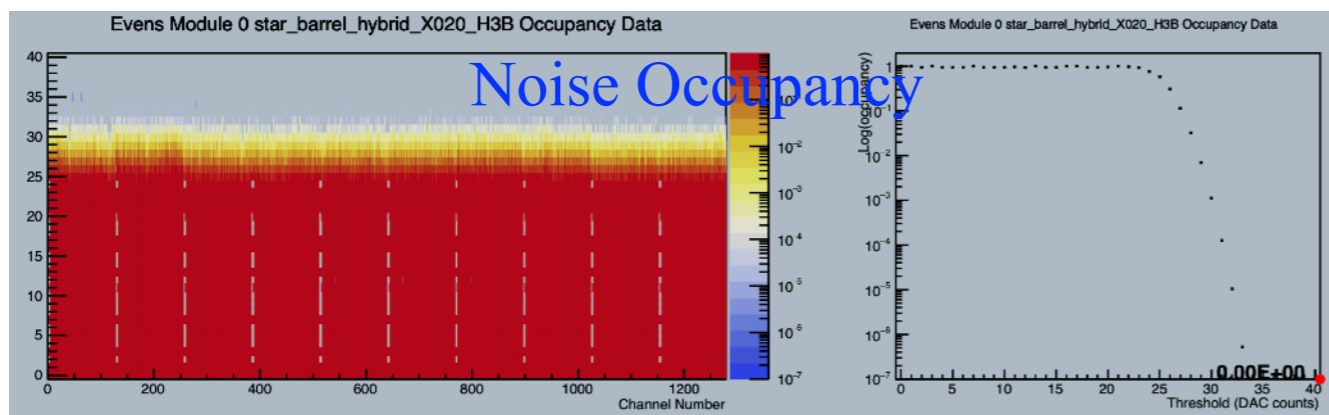
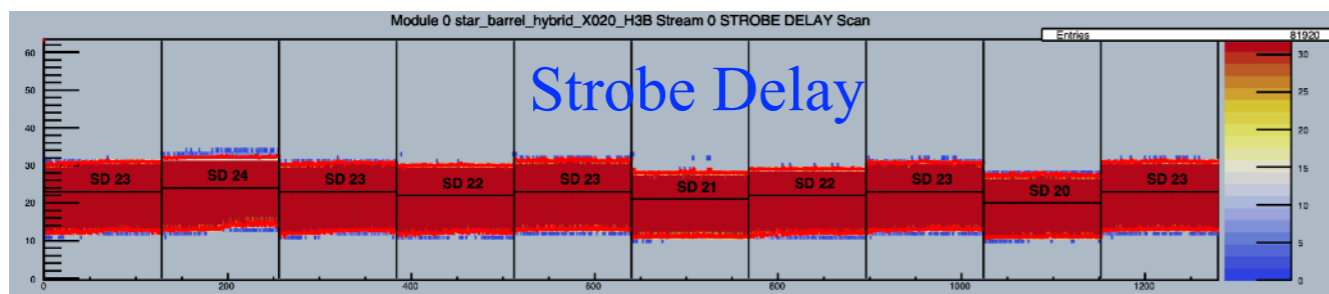
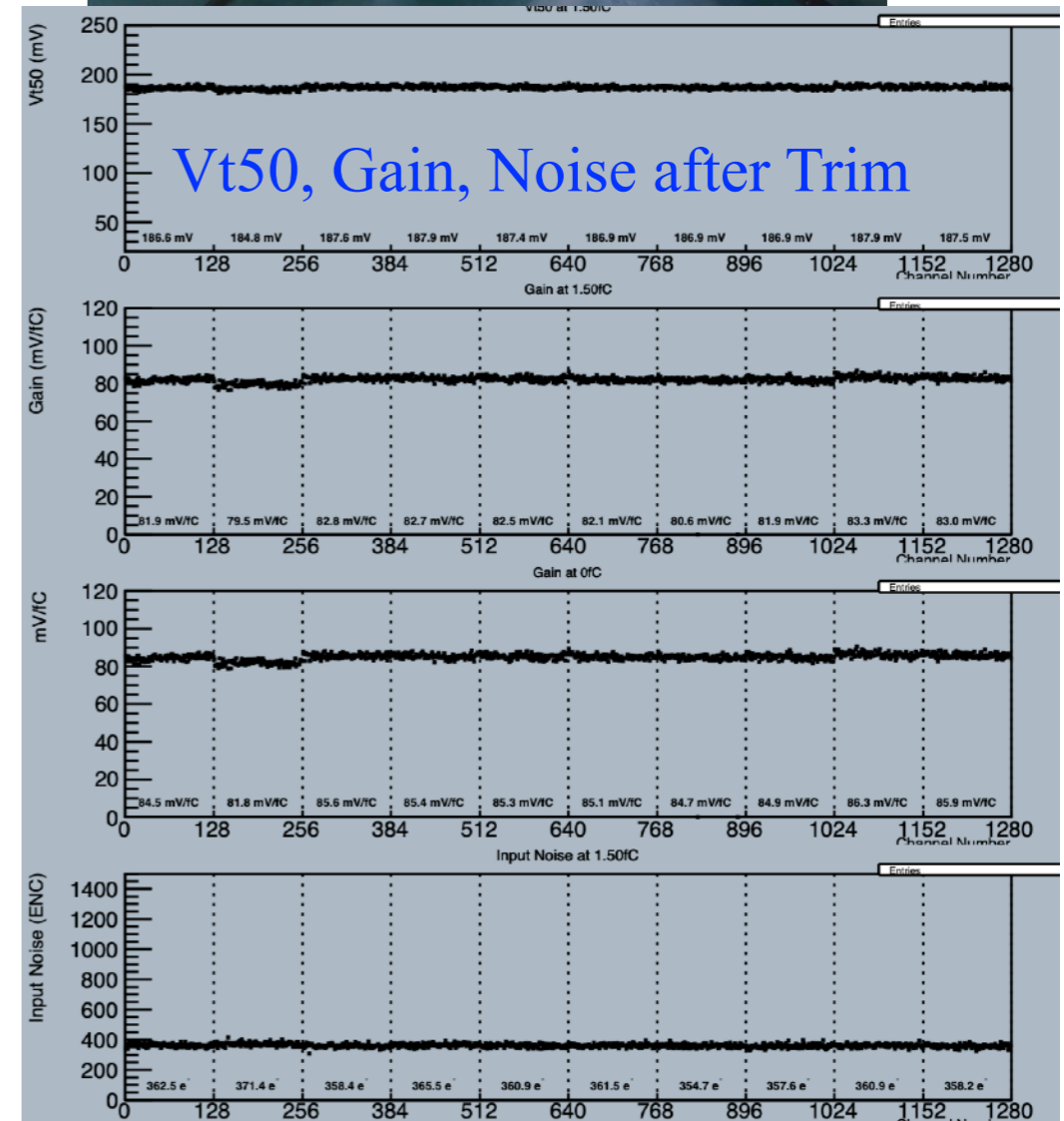
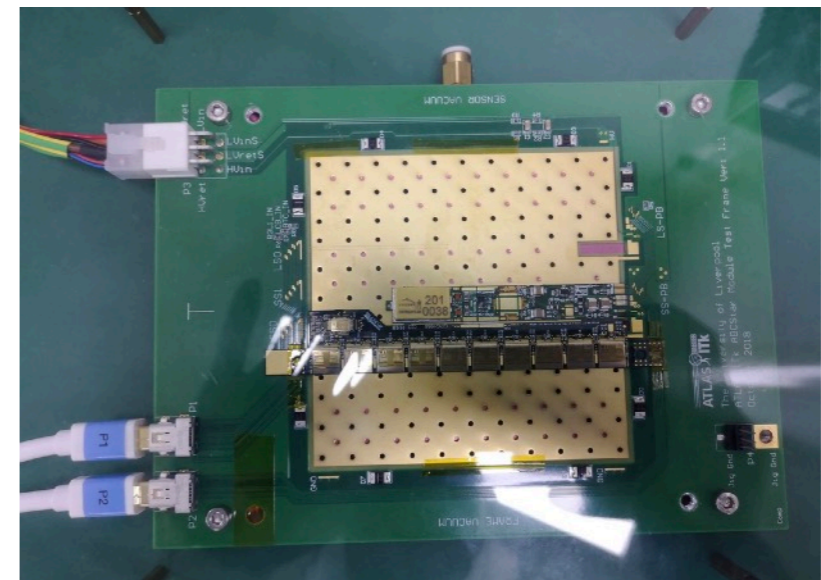
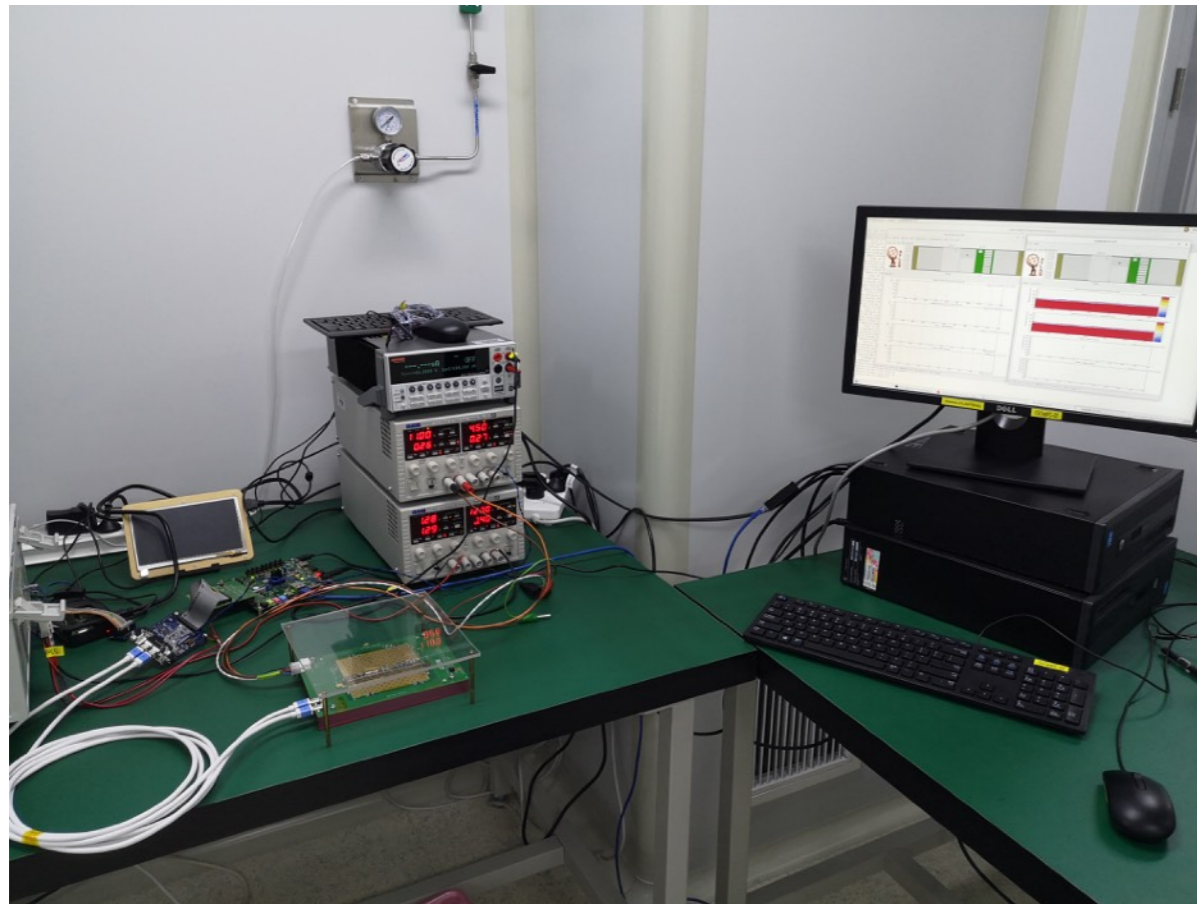
Noise Occupancy



- Noise Occupancy for thresholds (0.5-2.0 fC):

- ▶  $< 1 \times 10^{-3}$
- ▶ at least one order less than the hit occupancy (1%)

# Electrical Test on Hybrid with Star ASICs



# Hybrid Burn-in

- Check for early ASIC death,
- Long term ( $> 100$  h) tests on hybrids at  $\sim 40$  °C,
- Missing the Burn-in Crate(host 6 Hybrid Panels/36 Hybrids).

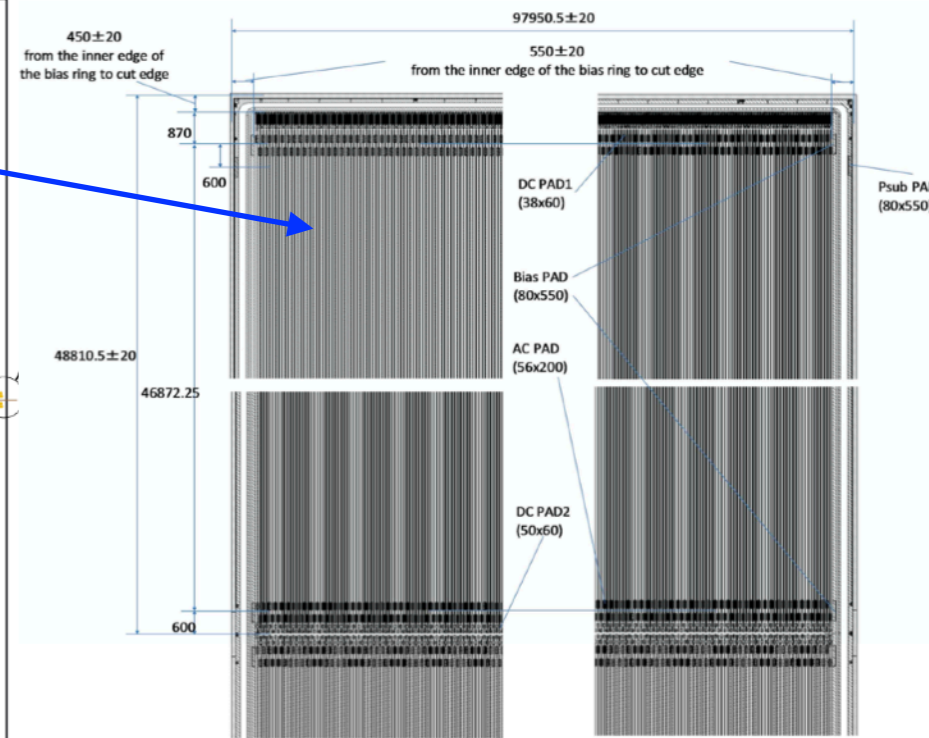
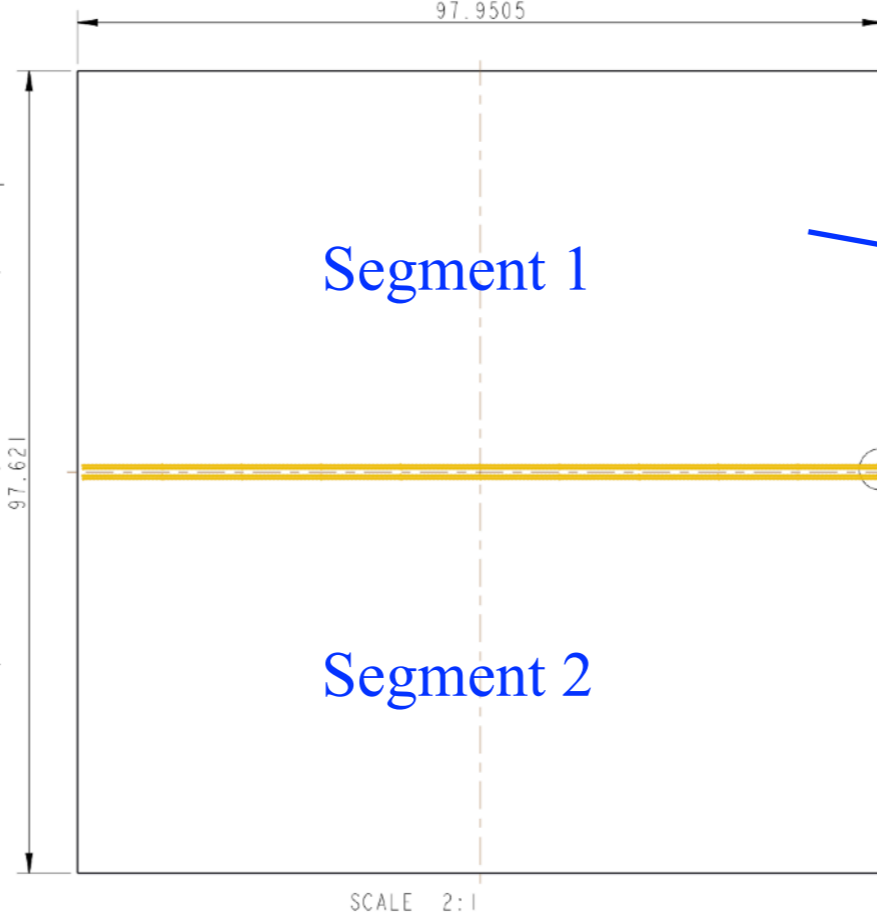
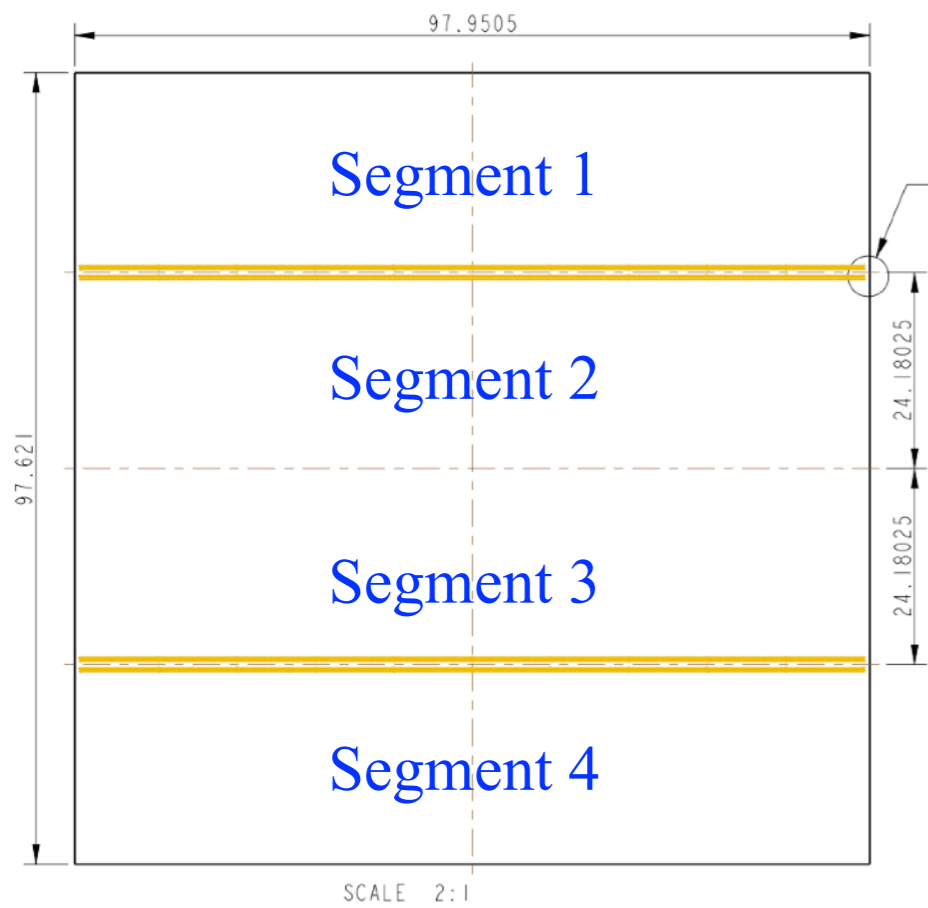


Hybrid Burn-in Crate



H&T Chamber at IHEP

# Main Sensor

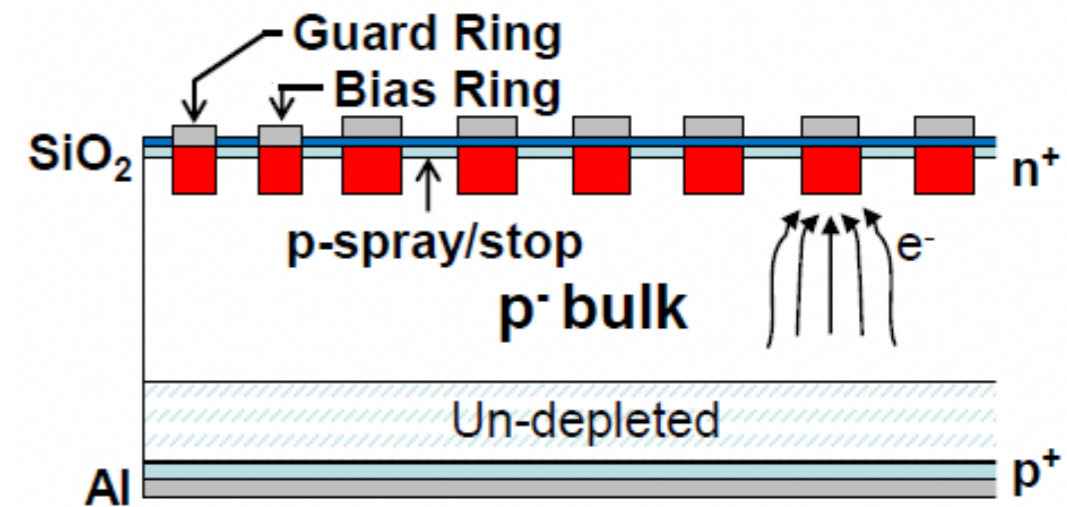


## Short Strip Sensor:

- ▶ Four Segments
- ▶ Strip Length: 2.4 cm
- ▶ 5120 read-out strips

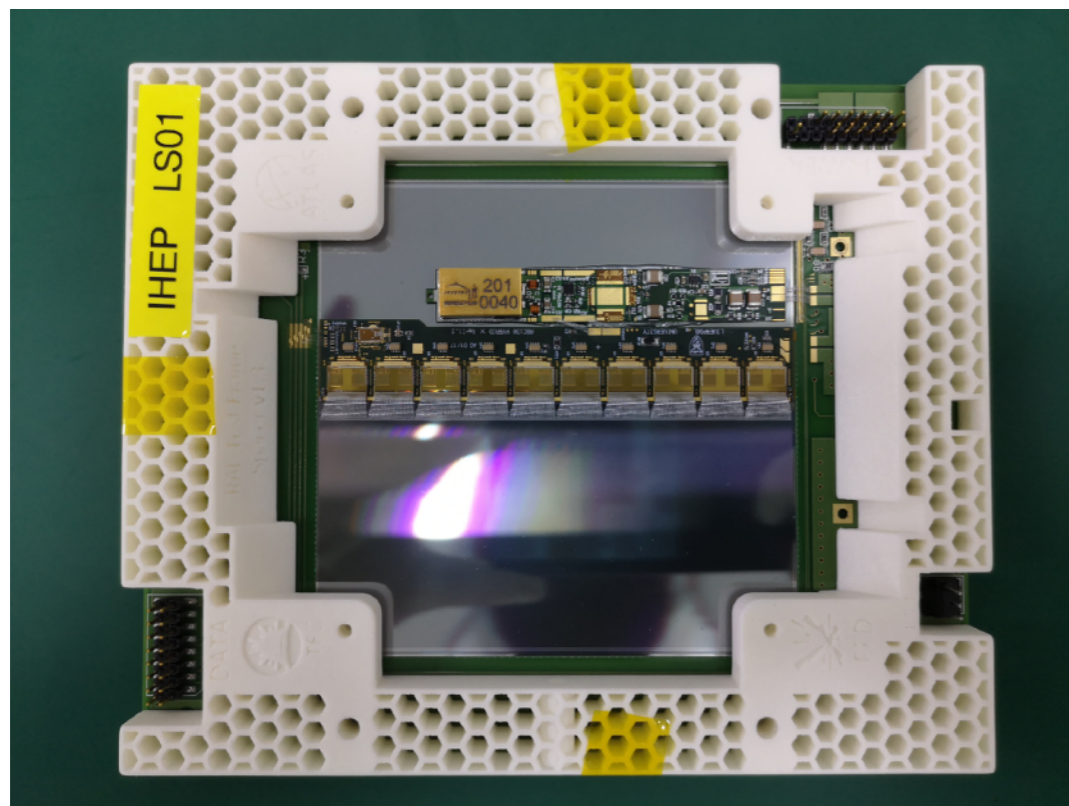
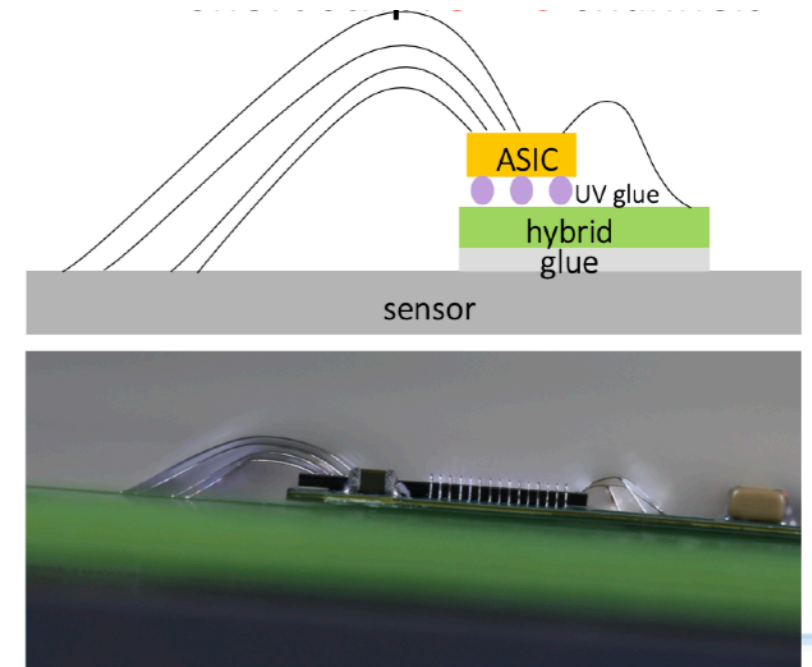
## Long Strip Sensor:

- ▶ Two Segments
- ▶ Strip Length: 4.8 cm
- ▶ 2560 read-out strips



# Electrical Modules at IHEP

- Two LS Modules with ABC/HCC130,
- Two LS Modules with ABC/HCCStar.



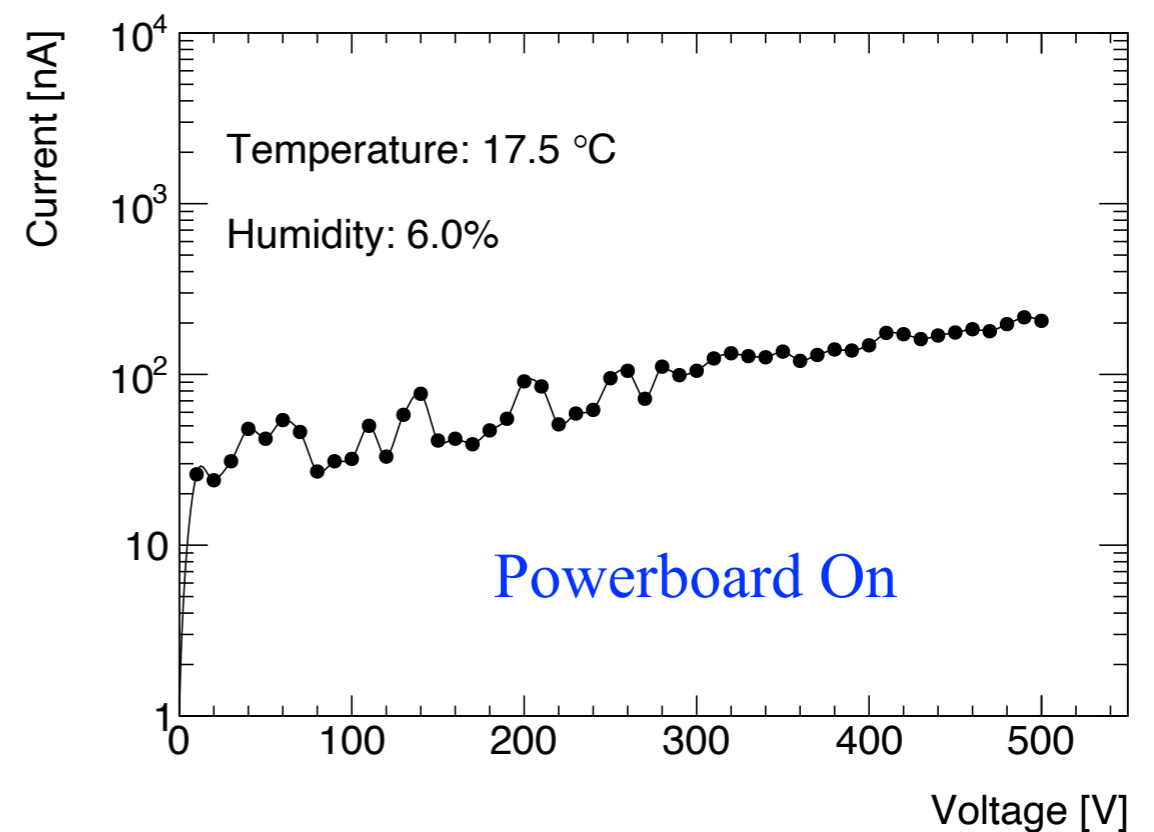
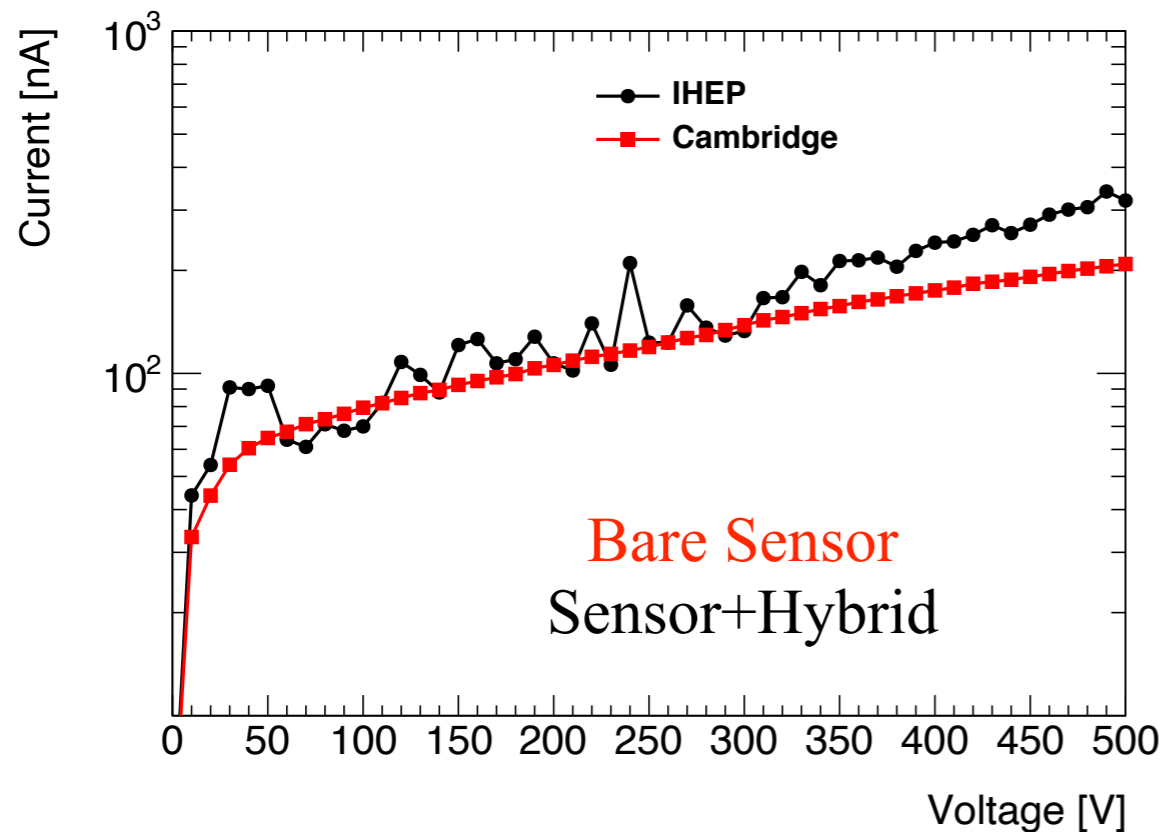
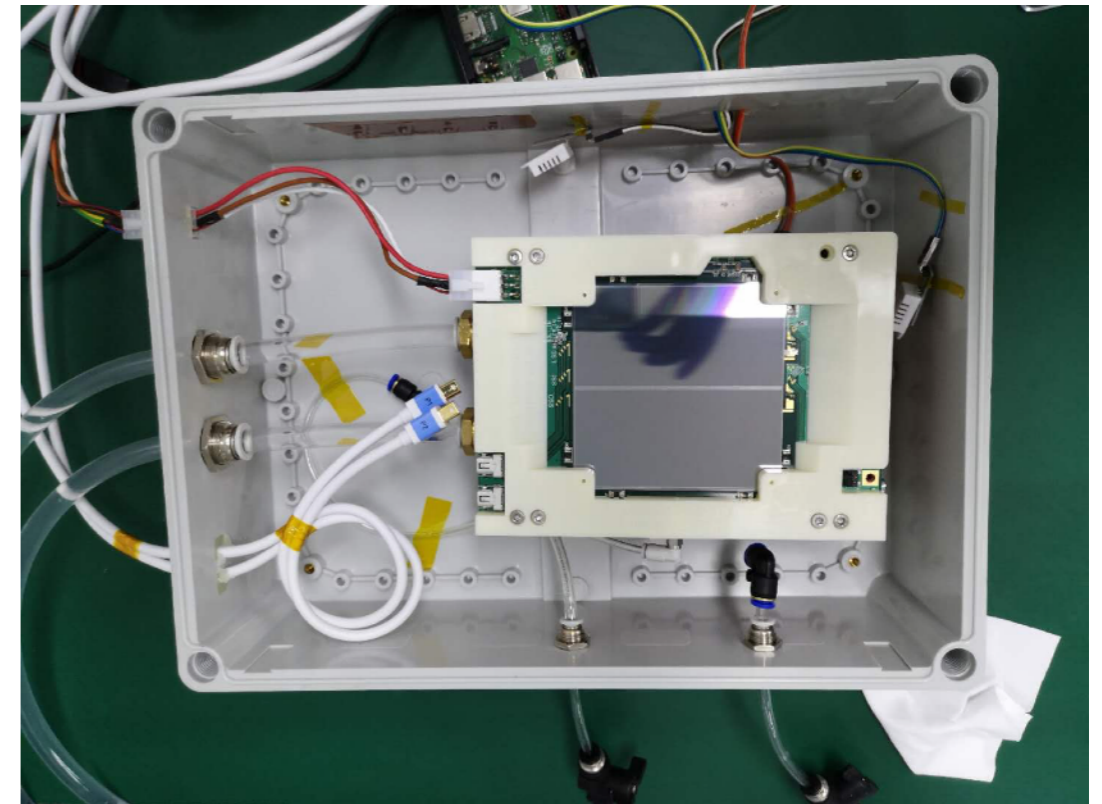
Electrical Module with ABC/HCC130



Electrical Module with ABC/HCCStar



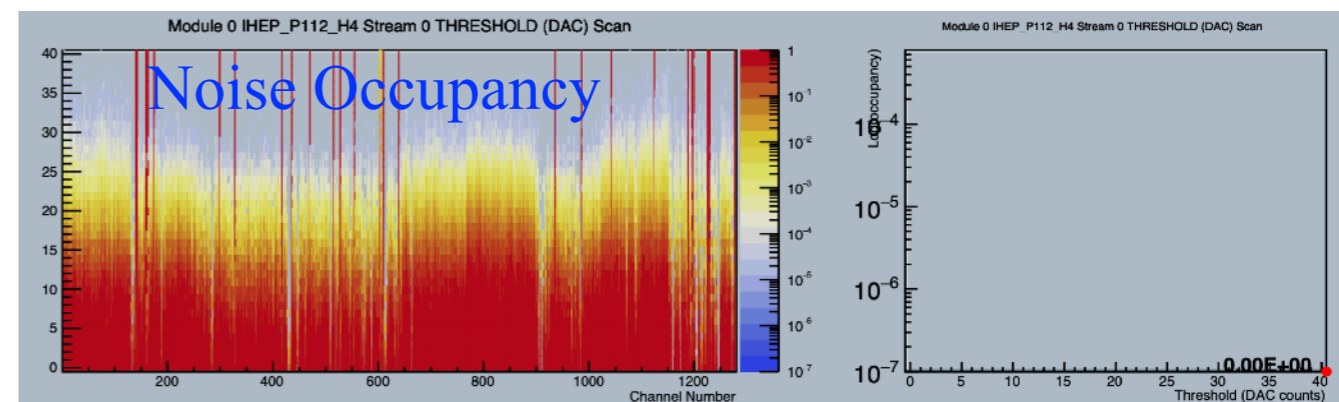
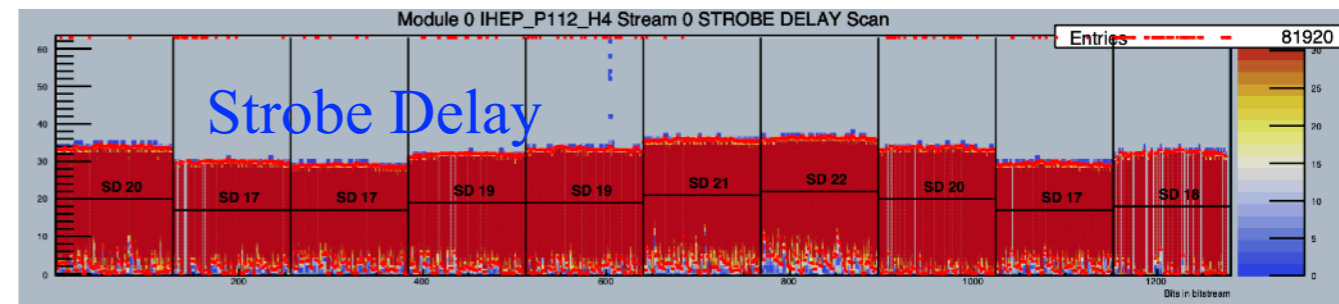
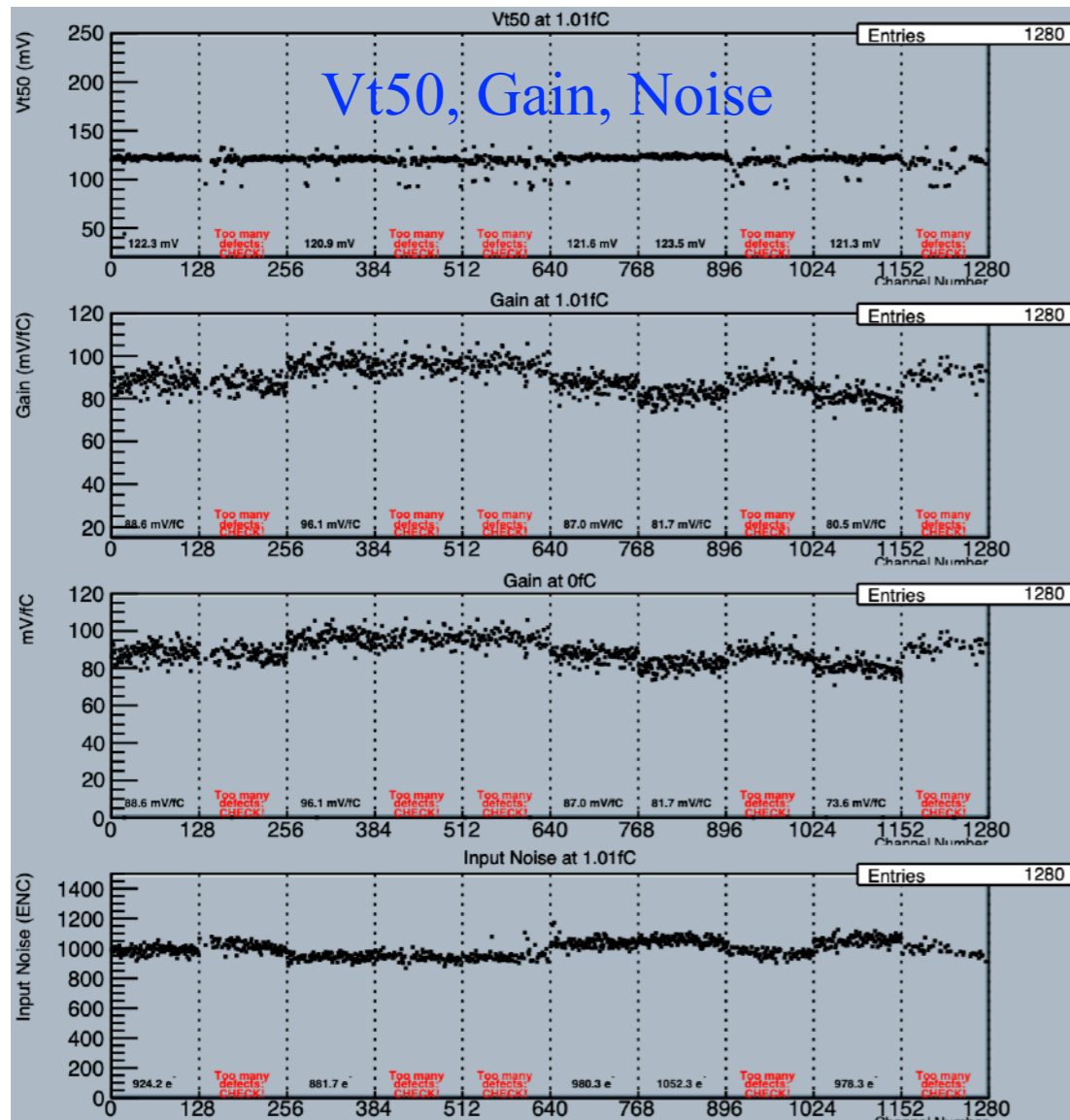
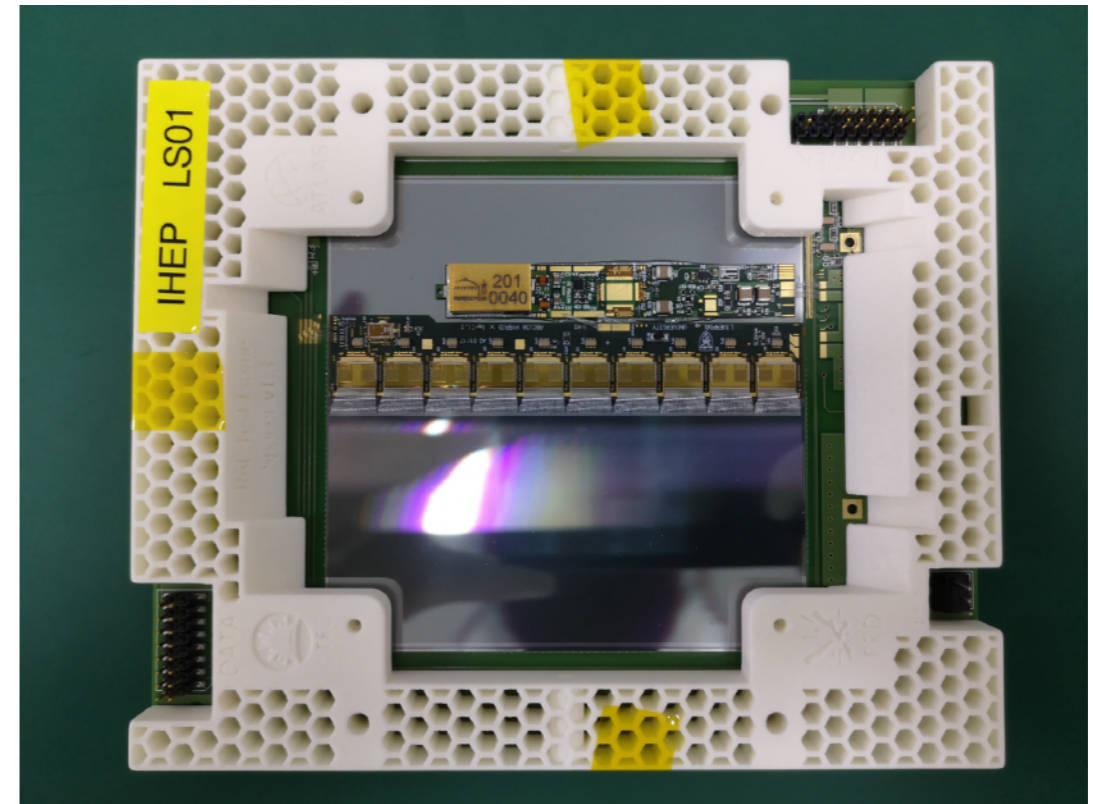
- Dark environment,
- T:  $\sim 17^\circ\text{C}$ , H:  $< 10\%$ ,
- IV characteristics of sensor before and after assembly should be consistent.



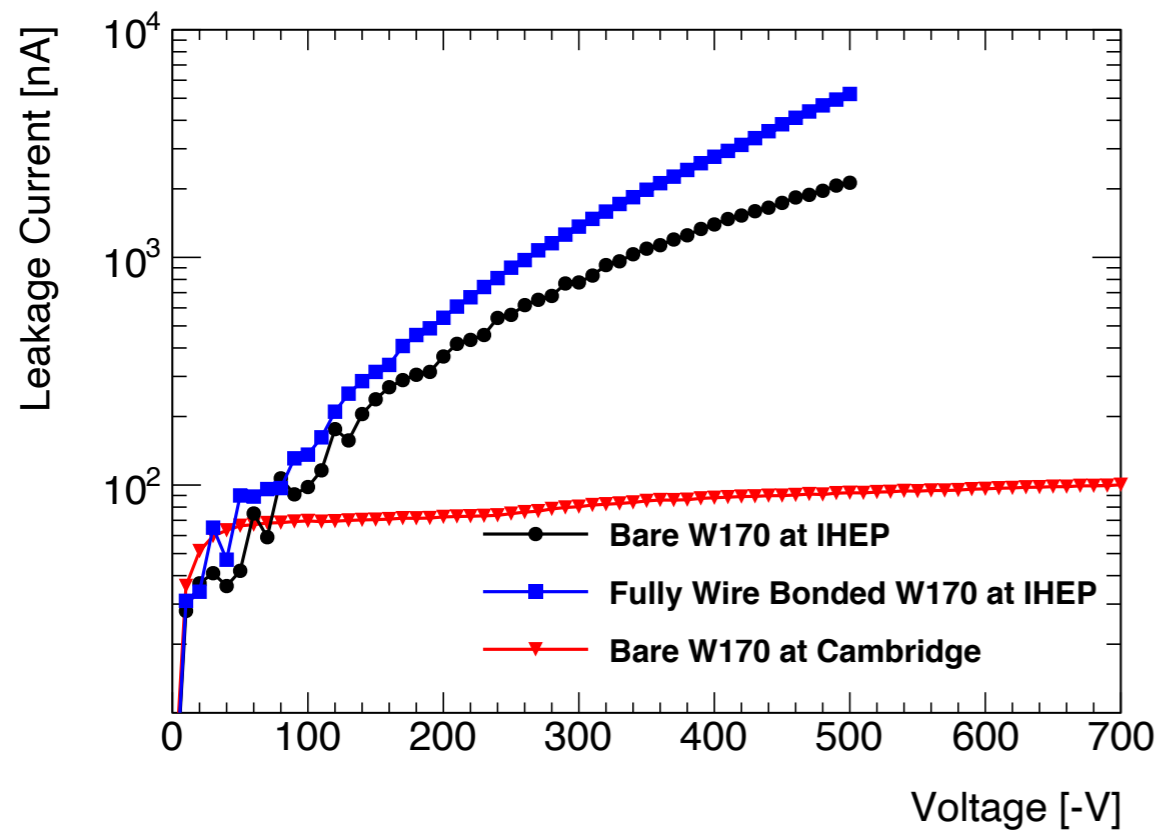
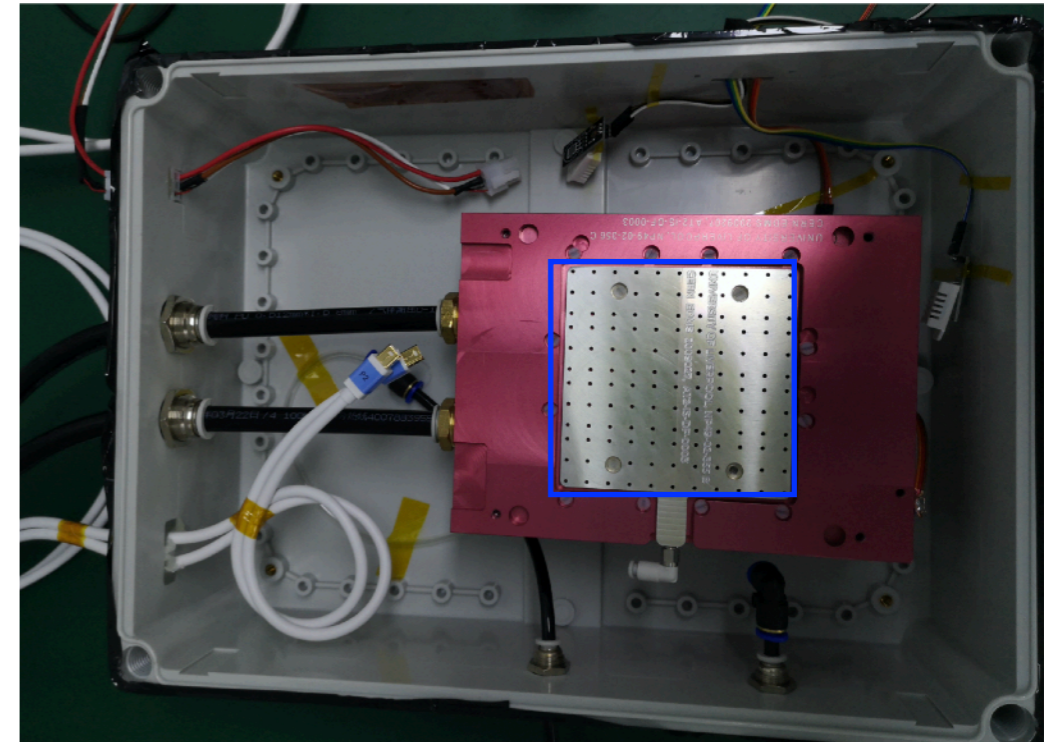
# Electrical Test on Module with ABC/HCC130



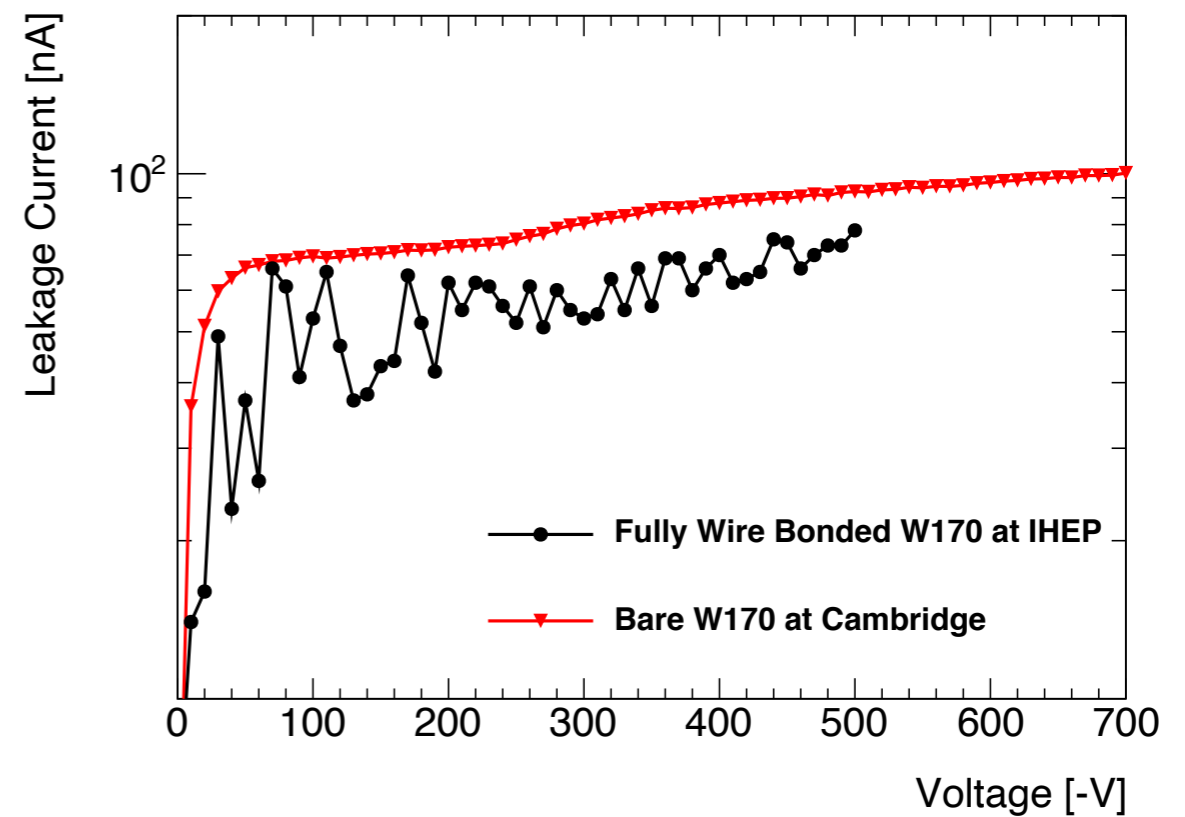
- First Electrical Module at IHEP,
- IHEP\_LS01 with 130 ASICs,
- Testbox: Dark, T:  $\sim 17^\circ\text{C}$ , H:  $< 10\%$ .



- Leakage current due to the poor insulation between HV plate of test chuck.
- Insulate HV plate(the blue area) and test chuck(add a layer of Kapton tape).



Before

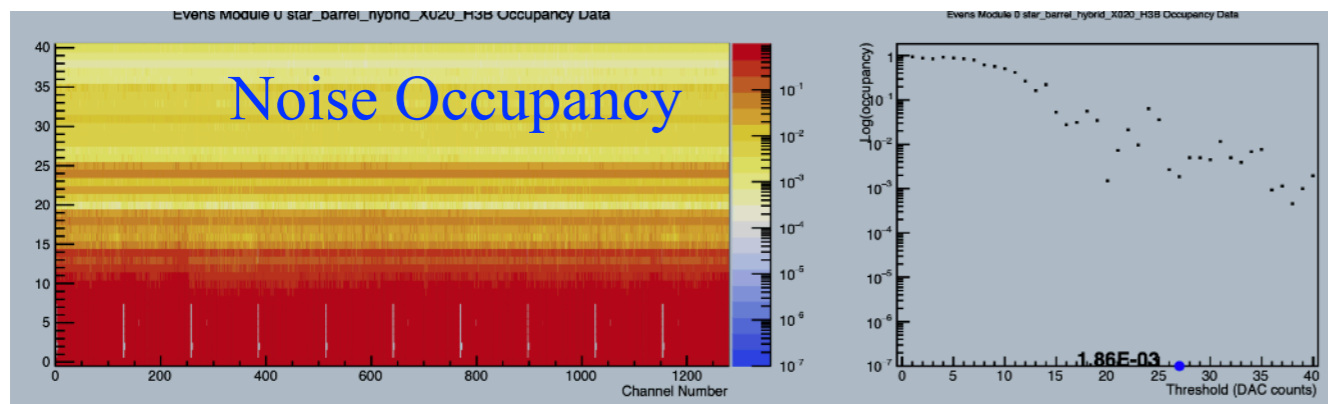
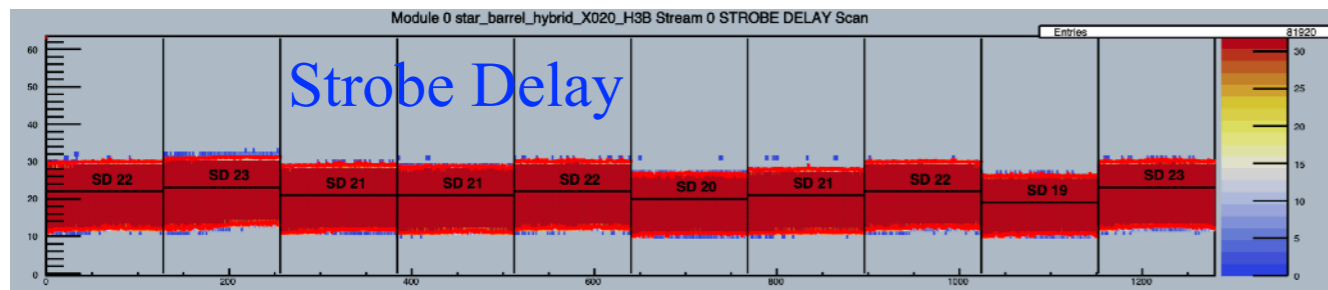
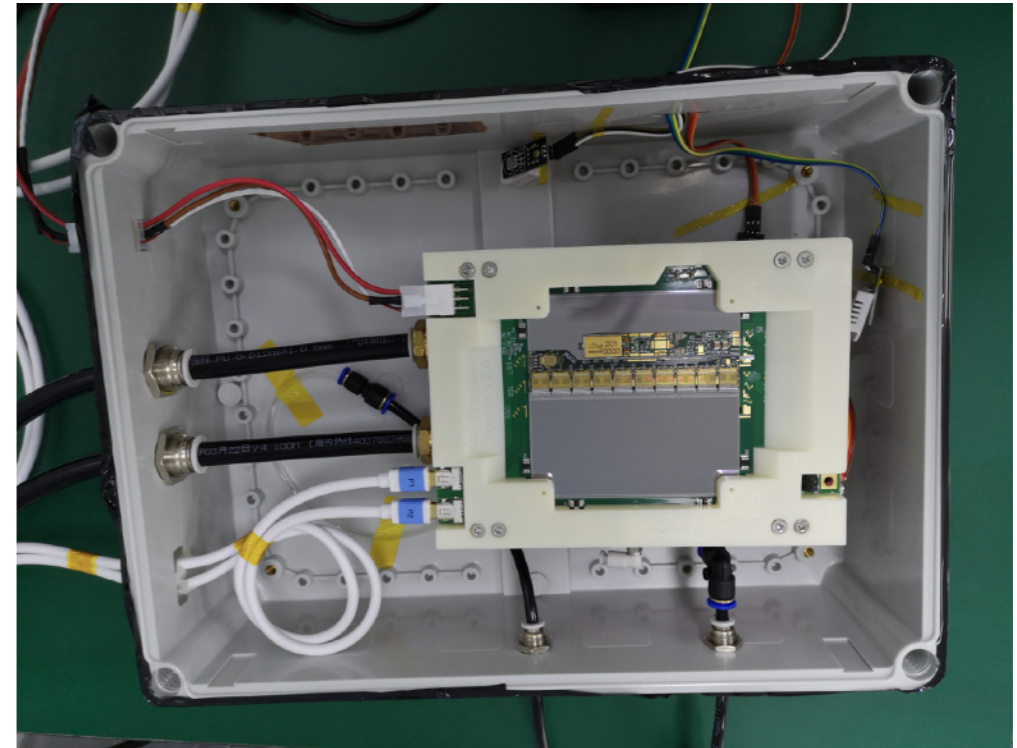


After

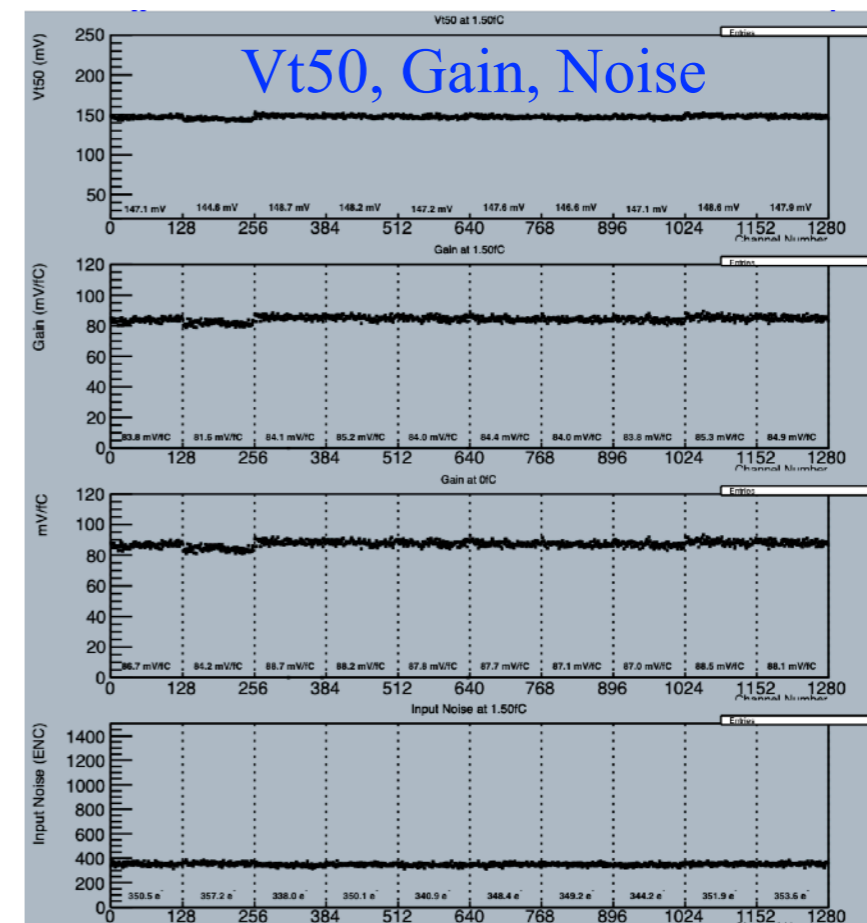
# Electrical Test on Module with ABC/HCCStar



- First fully functional star module at IHEP,
- Plan to mount on stave for system test.



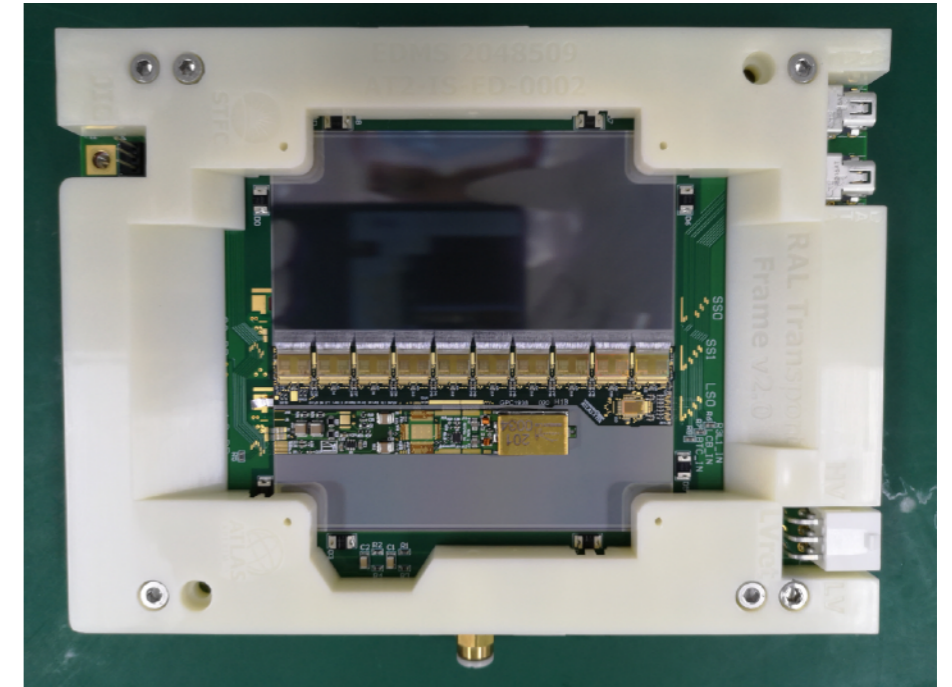
- Higher Noise Occupancy due to poor insulation between HV plate and test chuck. (Fixed)



# Electrical Test on Module with ABC/HCCStar



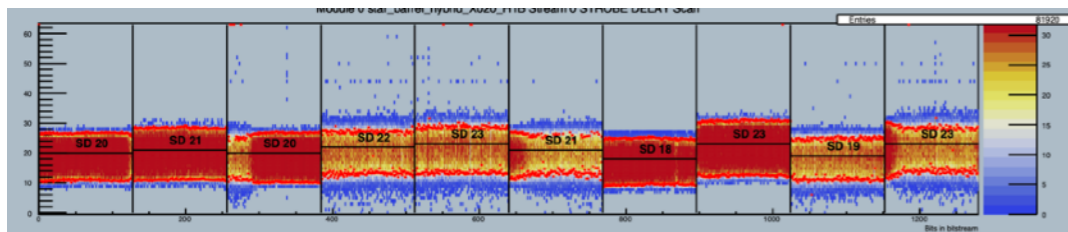
- Second Star LS Module
- Electrical Test:
  - Stream 1 fully functional,
  - Stream 0 not stable, failed Strobe Delay and RC



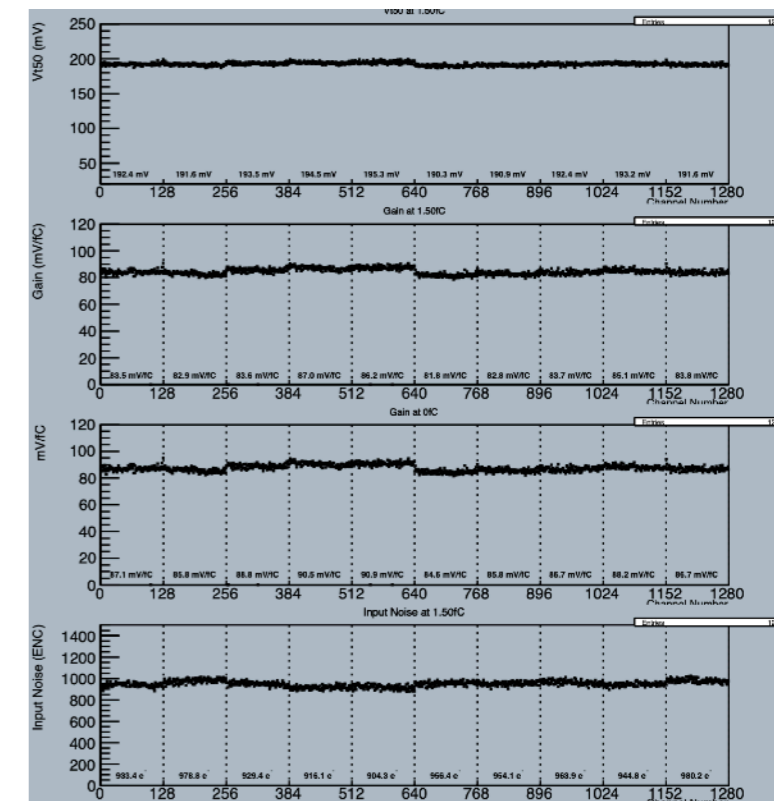
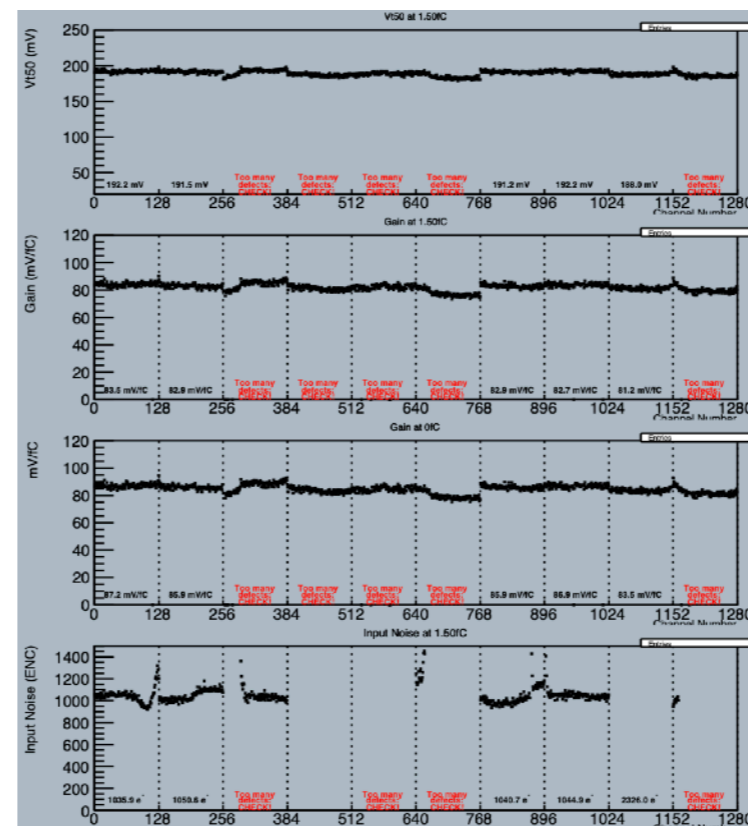
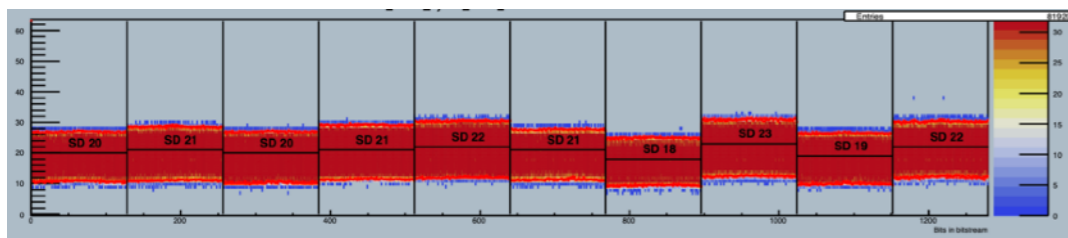
Stream 0

Stream 1

Stream 0

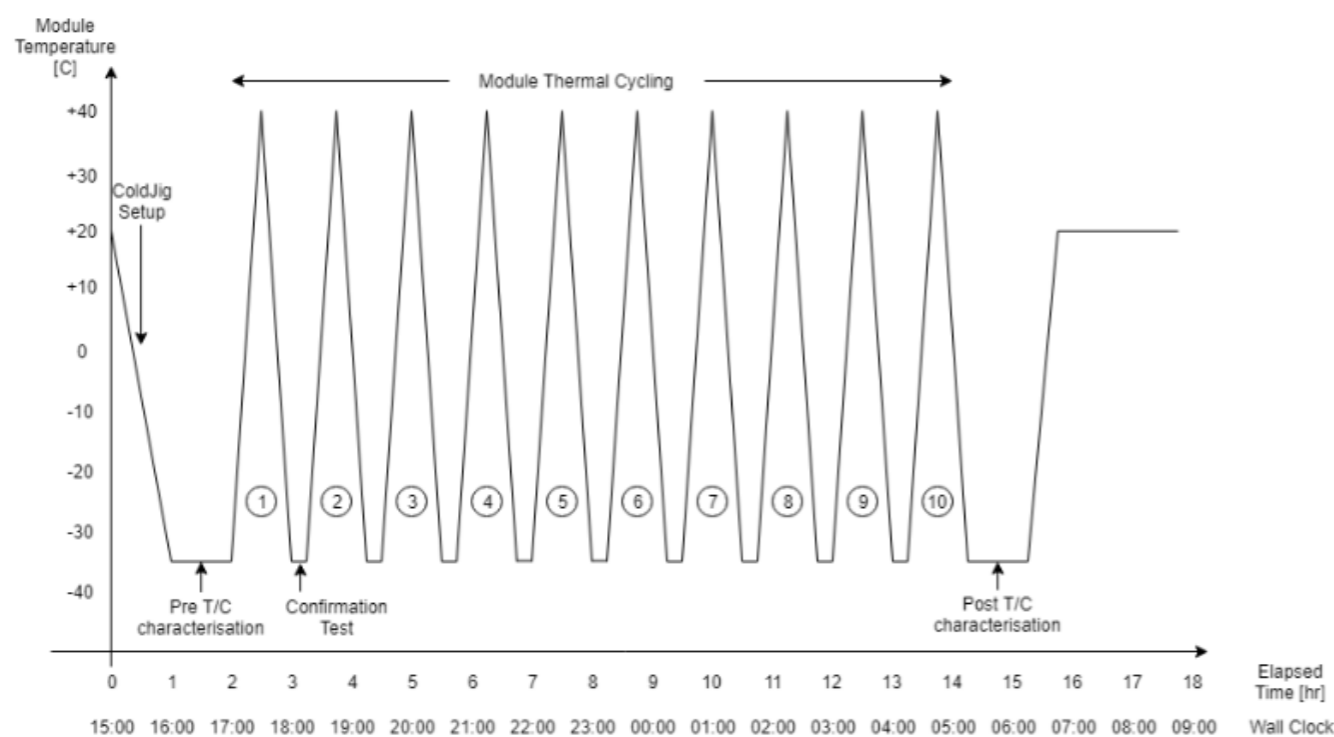


Stream 1

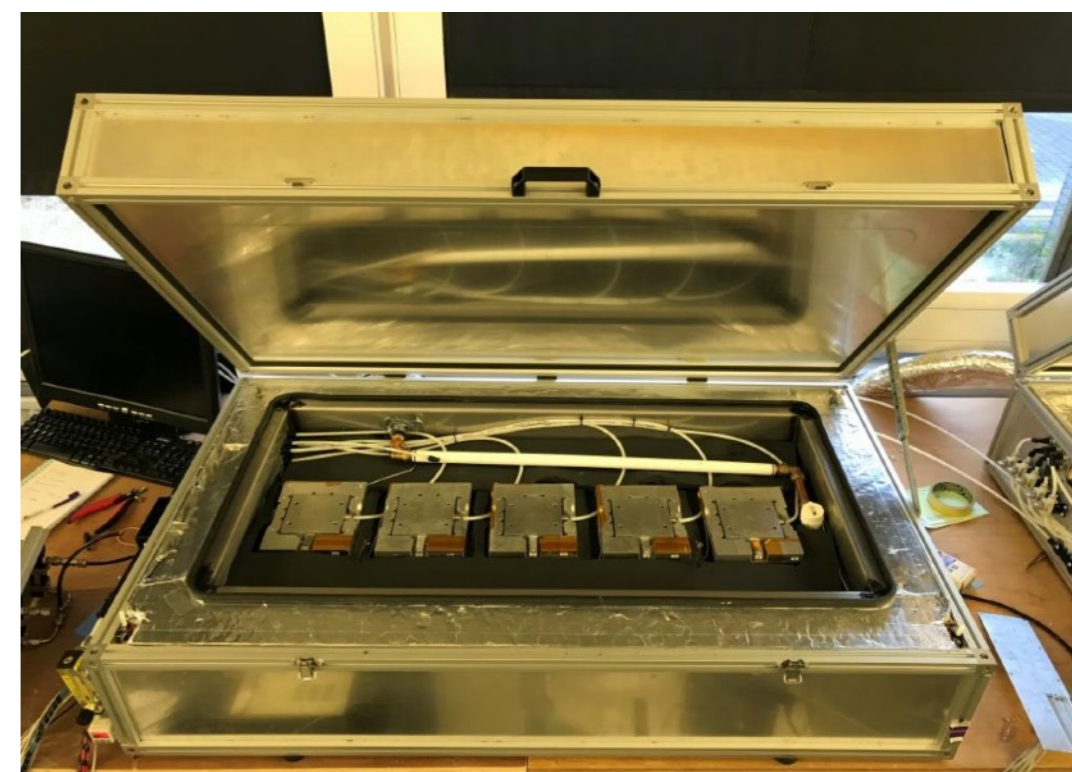


# Module Thermal Cycling

- Thermal-cycling between  $-35\text{ }^{\circ}\text{C}$  to  $+40\text{ }^{\circ}\text{C}$ , 10 times over 12 hours,
- Module test before and after the thermal cycling period, and between each thermal cycle,
- Expect to get ColdJig at the end of October.



Thermal Cycling Timeline

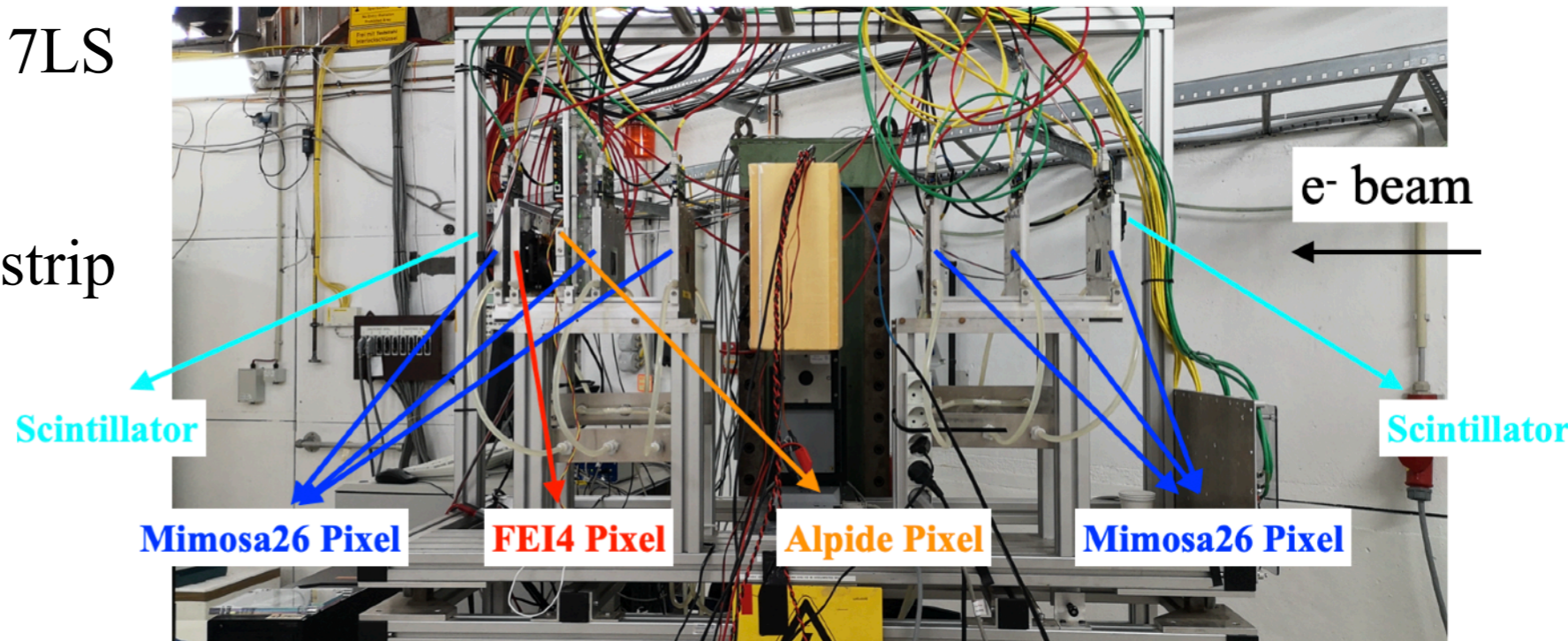
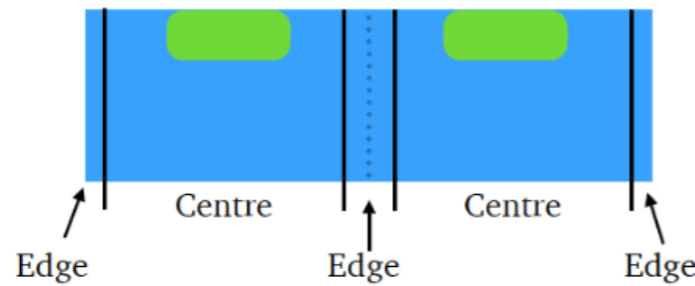


ColdJig at Warwick

# Beam Test

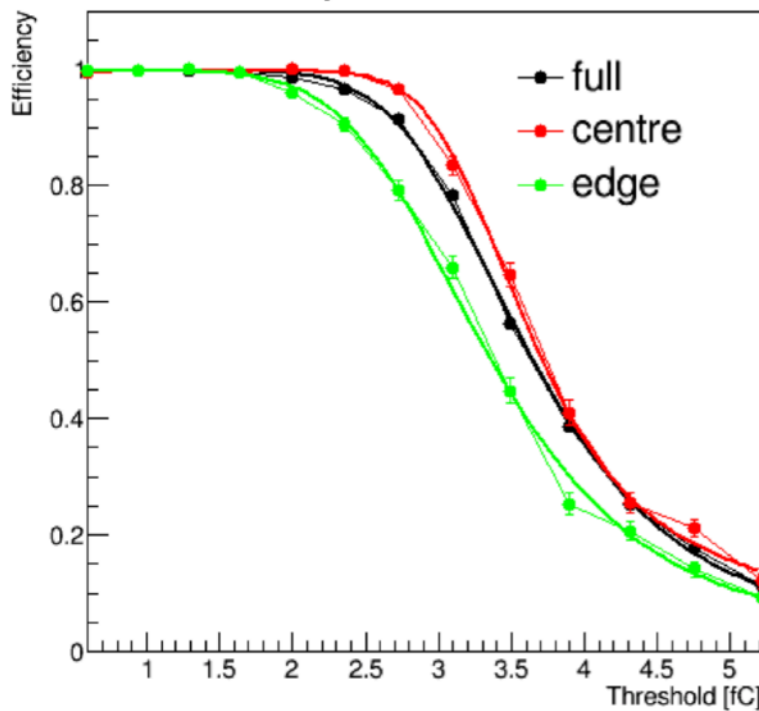


- Module built using ATLAS17LS sensor and star-chipset
- Define “edge” of strip/inter-strip region of 15  $\mu\text{m}$

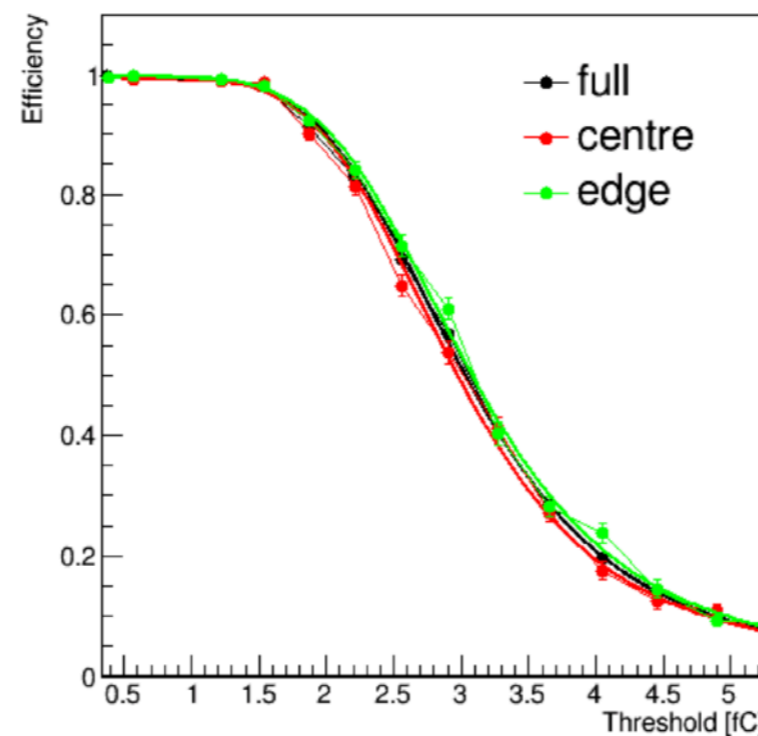


EUDET-type telescope

Perpendicular



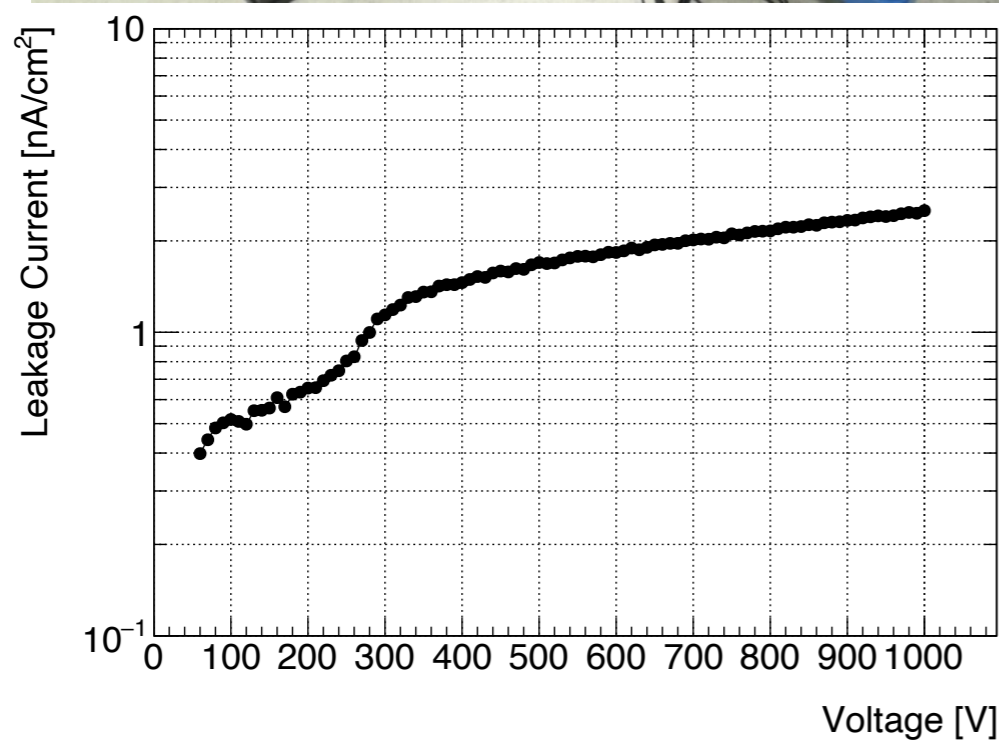
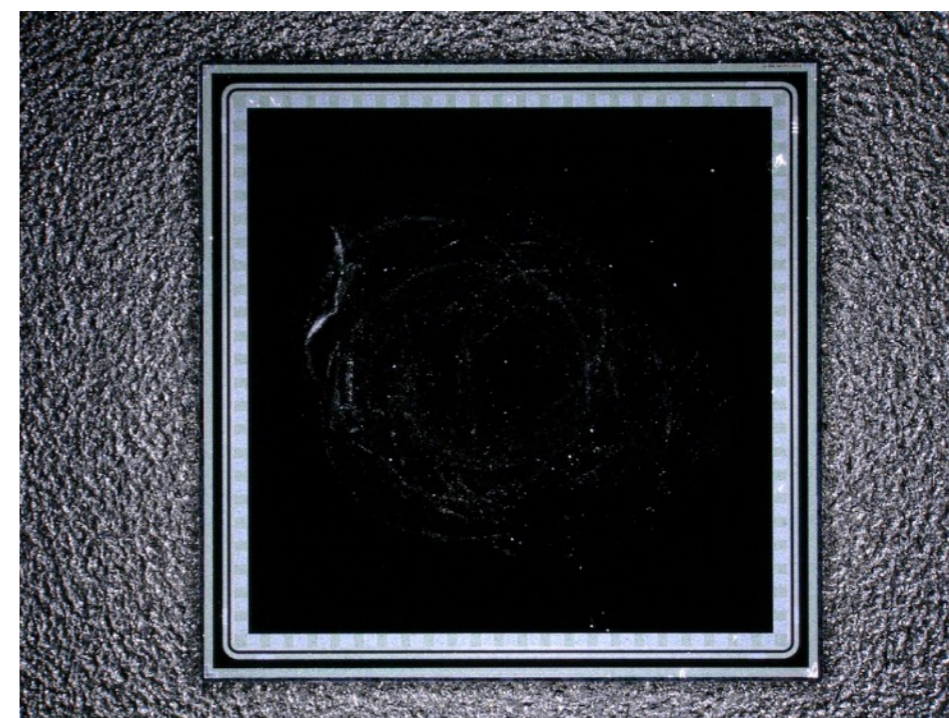
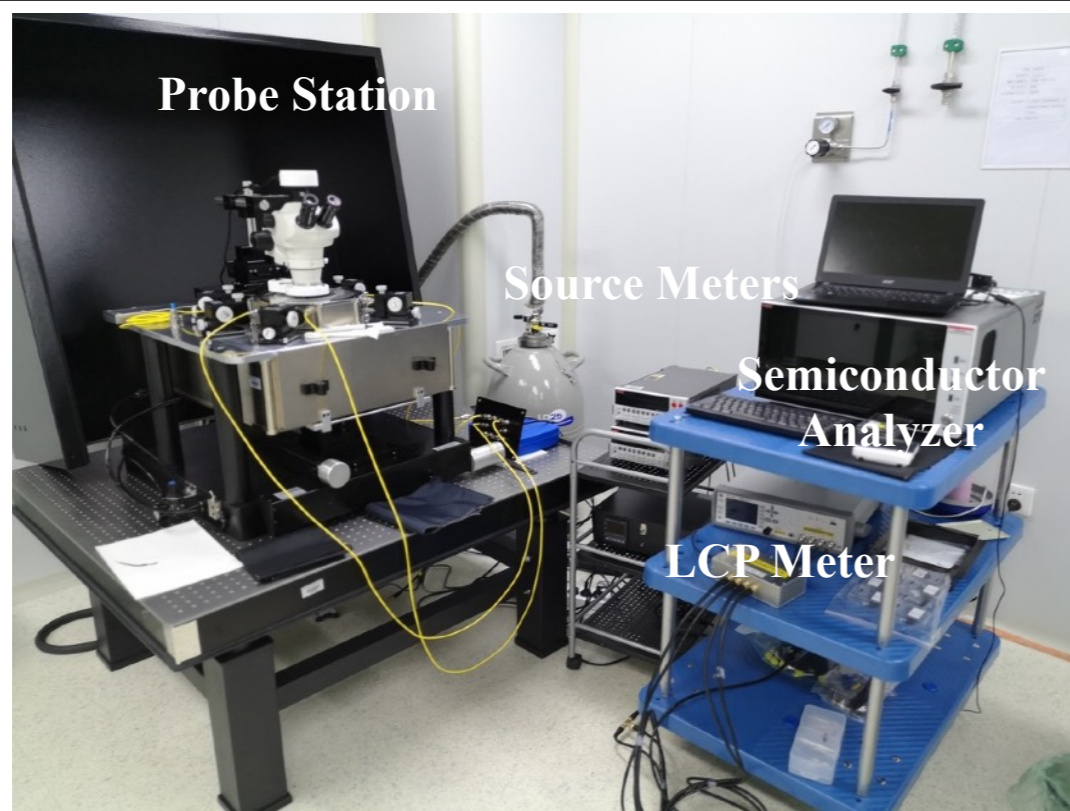
12° to beam



Median charge	Overall	Centre	Edge
Perpendicular to beam	3.65 fC	3.72 fC	3.37 fC
12° to beam	3.03 fC	2.97 fC	3.08 fC

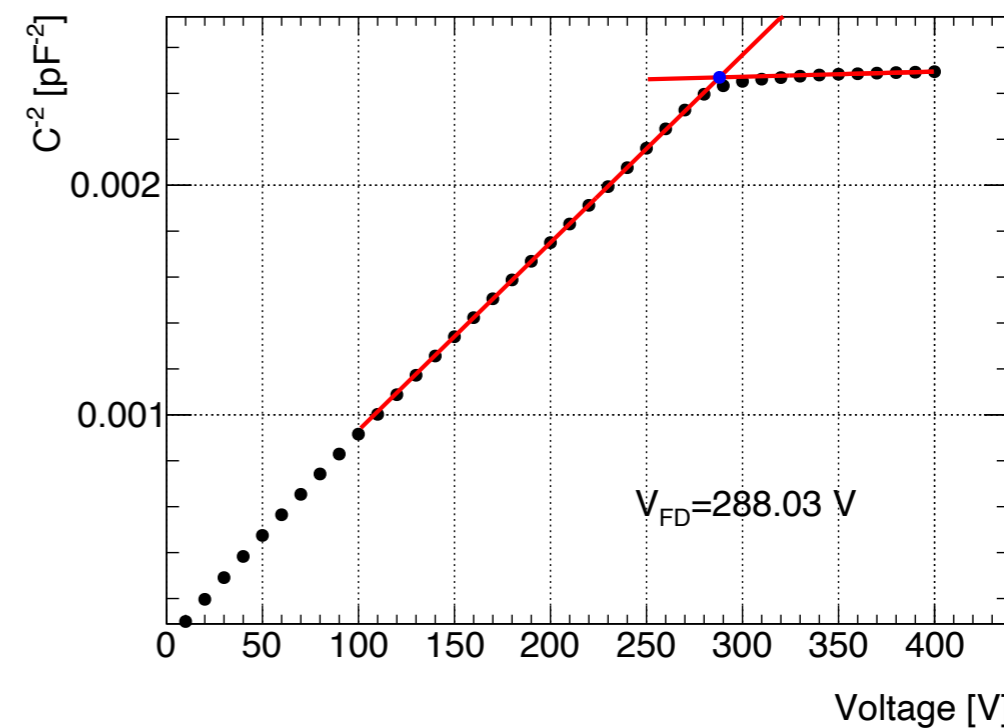
Lower efficiency for inter-strip region mainly due to charge sharing between strips

# Mini Sensor Studies



Leakage Current  $< 0.1 \mu\text{A}/\text{cm}^2$  at 500 V

Onset of micro-discharge Voltage  $> 500$  V



$V_{\text{FD}} < 350$  V



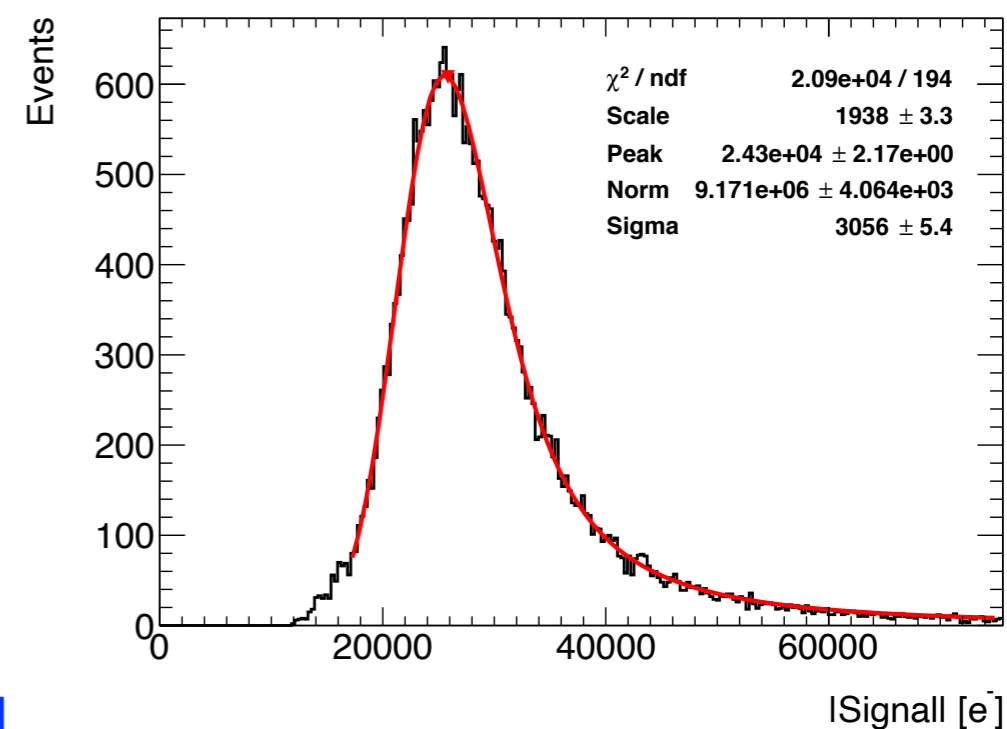
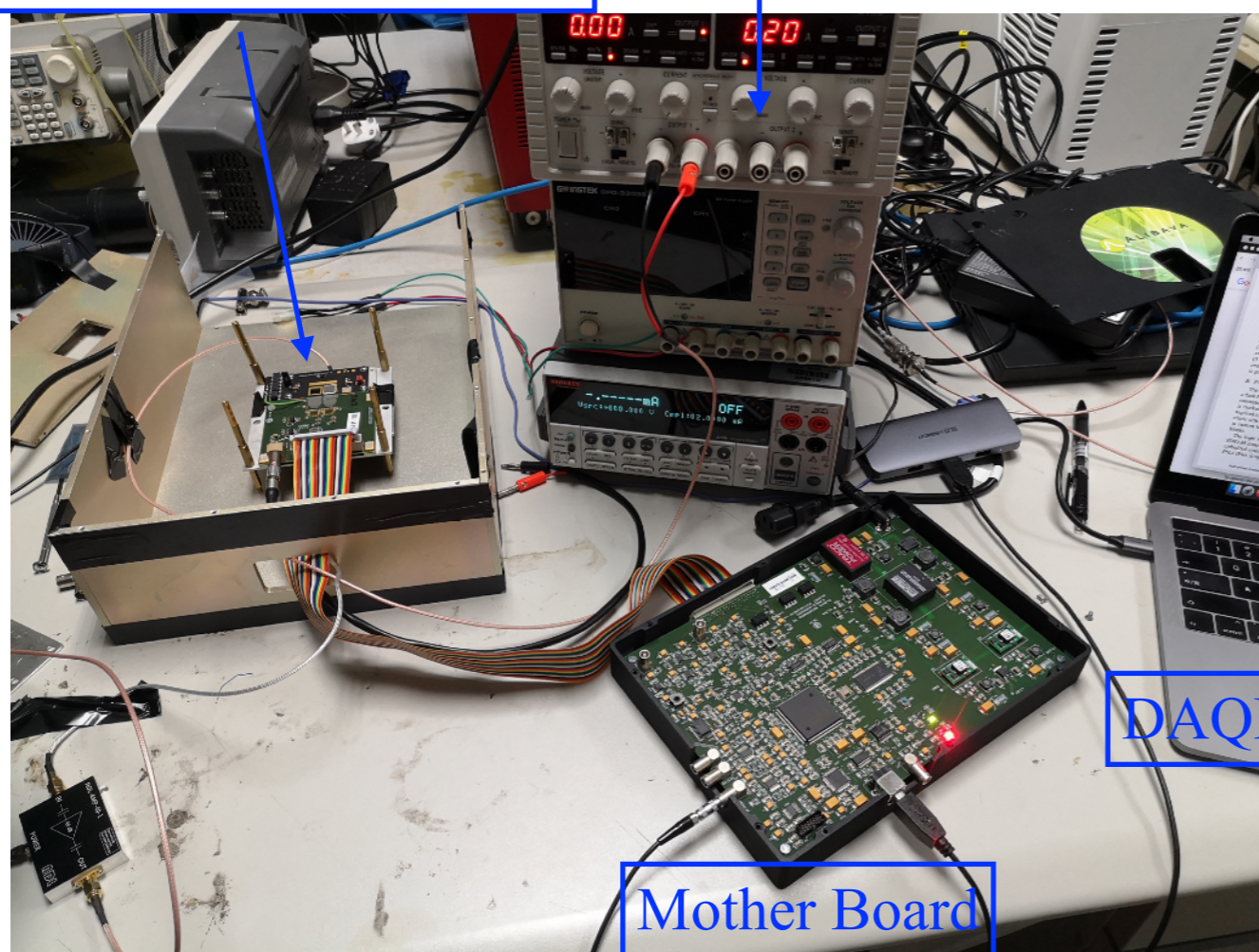
# Mini sensor studies with ALiBaVa System

- Set up the ALiBaVa system,
- Study the properties of mini sensor w/o irradiation using beta source.

Daughter and Detector Board  
Beta Source  
Scintillator

Power

Signal Shape



**More details in Yebo's talk.**



- Assembled several electrical Hybrids and Modules,
- Performed electrical test on Hybrids, Sensors and Modules.
- Plan:
  - Expect more sensors and ASICs,
  - Waiting for the Hybrid burn-in and Module thermal cycling setups.

Thanks